

# TMAG5173-Q1 High-Precision 3D Hall-Effect Sensor With I<sup>2</sup>C Interface

## 1 Features

- High-precision linear 3D Hall-effect sensor to optimize position sensing speed and accuracy:
  - Sensitivity room temperature error, X, Y, Z axes:  $\pm 2.5\%$  (maximum)
  - Sensitivity mismatch temperature drift X-Y axes:  $\pm 2\%$  (maximum)
  - X-Y angle measurement room temperature error:  $\pm 1.1^\circ$  (maximum)
  - X-Y angle measurement temperature drift:  $\pm 1.2^\circ$  (maximum)
  - 20 kSPS conversion rate for single axis
- **Functional Safety-Compliant:**
  - Developed for functional safety applications
  - [Documentation available to aid ISO 26262 system design](#)
  - Systematic capability up to ASIL D
  - Hardware integrity up to ASIL B or SIL 2
- AEC-Q100 qualified for automotive applications:
  - Temperature grade 1:  $-40^\circ\text{C}$  to  $125^\circ\text{C}$
- Ultra-low power saving mode:
  - 8 nA (typical) sleep mode current
- Selectable linear magnetic range at X, Y, or Z axis:
  - TMAG5173x1-Q1:  $\pm 40\text{ mT}$ ,  $\pm 80\text{ mT}$
  - TMAG5173x2-Q1:  $\pm 133\text{ mT}$ ,  $\pm 266\text{ mT}$
- Interrupt signal from user-defined magnetic and temperature threshold cross
- Configurable unipolar and omnipolar switch function
- Integrated angle CORDIC calculation with gain and offset adjustment
- Configurable averaging filter for noise reduction
- I<sup>2</sup>C interface with cyclic redundancy check (CRC):
  - Maximum 1 MHz I<sup>2</sup>C clock speed
- Conversion trigger by I<sup>2</sup>C or dedicated  $\overline{\text{INT}}$  pin
- Integrated temperature compensation for multiple magnet types
- Built-in temperature sensor
- 2.3 V to 3.6 V supply range
- I<sup>2</sup>C and  $\overline{\text{INT}}$  pin tolerance: 5.5 V (maximum)

## 2 Applications

- [Steering column control](#)
- [Steering wheel control](#)
- [Shifter systems](#)
- [E-bikes](#)
- [Actuators](#)
- [Door module](#)
- [Power seats](#)
- [Magnetic proximity switch](#)

## 3 Description

The TMAG5173-Q1 is a low-power linear 3D Hall-effect sensor designed for a wide range of automotive and industrial applications. This device integrates three independent Hall-effect sensors in the X, Y, and Z axes. A precision analog signal-chain supports applications requiring narrow design tolerance. Integrated safety mechanisms enable robust functional safe system design. The device is suitable for 1D linear measurements, 2D angle measurements, 3D joystick measurements, magnetic threshold cross detection, and various user configurable switch function applications. The digital filter option allows up to 32 times sensor data integration for improved noise performance. The I<sup>2</sup>C interface, while supporting multiple operating V<sub>CC</sub> ranges, ensures seamless data communication with microcontrollers. The device has an integrated temperature sensor available for multiple system functions, such as thermal budget check or temperature compensation calculation for a given magnetic field.

The TMAG5173-Q1 supports multiple operating modes to optimize the system power consumptions and operating speed. During the active mode the device performs continuous conversions autonomously. During standby mode the  $\overline{\text{INT}}$  pin or I<sup>2</sup>C communication can be used by a microcontroller to trigger a new conversion. During the sleep mode the device consumes ultra-low power and retains the configuration register values.

An integrated angle calculation engine (CORDIC) provides full 360° angular position information for both on-axis and off-axis topologies with an angle resolution of 1/16 degree. The angle calculation is performed for any of the X-Y, Y-Z, or Z-X planes based off the user configuration register selection. The device features magnetic gain and offset correction to mitigate the impact of system mechanical error sources.

The TMAG5173-Q1 can be configured through the user registers to enable any combination of magnetic axes and temperature channel conversions. The device supports several I<sup>2</sup>C read frames along with cyclic redundancy check and diagnostic status communications.



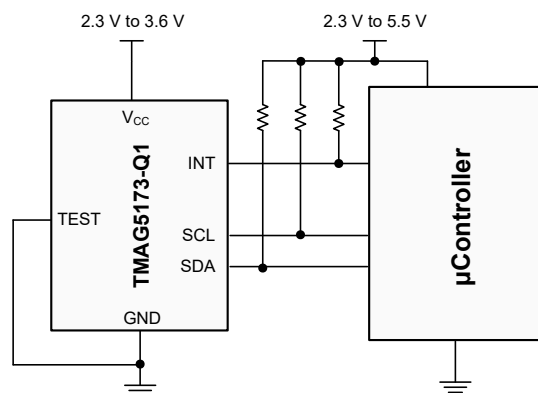
The TMAG5173-Q1 is offered in four different factory-programmed I<sup>2</sup>C addresses. The device also supports additional I<sup>2</sup>C addresses through the modification of a user-configurable I<sup>2</sup>C address register. Each orderable part can be configured to select one of two magnetic field ranges that suits the magnet strength and component placement during system calibration.

The device performs consistently across a wide ambient temperature range of –40°C to +125°C.

### Package Information

| PART NUMBER | PACKAGE <sup>(1)</sup> | PACKAGE SIZE <sup>(2)</sup> |
|-------------|------------------------|-----------------------------|
| TMAG5173-Q1 | DBV (SOT-23, 6)        | 2.9 mm × 2.8 mm             |

- (1) For all available packages, see the package option addendum at the end of the data sheet.  
 (2) The package size (length × width) is a nominal value and includes pins, where applicable.



**Application Block Diagram**

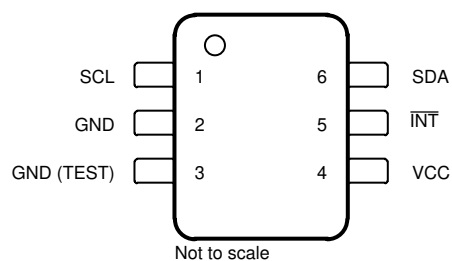
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## 4 Revision History

| Changes from Revision * (September 2022) to Revision A (September 2023)       | Page     |
|-------------------------------------------------------------------------------|----------|
| • Changed data sheet status from Advanced Information to Production Data..... | <b>1</b> |

## 5 Pin Configuration and Functions



**Figure 5-1. DBV Package, 6-Pin SOT-23 (Top View)**

**Table 5-1. Pin Functions**

| PIN |            | TYPE | DESCRIPTION                                                                       |
|-----|------------|------|-----------------------------------------------------------------------------------|
| NO. | NAME       |      |                                                                                   |
| 1   | SCL        | IO   | Serial clock.                                                                     |
| 2   | GND        | GND  | Ground                                                                            |
| 3   | GND (TEST) | I    | TI Test Pin. Connect to ground in application.                                    |
| 4   | VCC        | P    | Supply voltage                                                                    |
| 5   | INT        | IO   | Interrupt input/ output. If not used and connected to ground, set MASK_INTB = 1b. |
| 6   | SDA        | IO   | Serial data.                                                                      |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                                    | MIN  | MAX       | UNIT |
|------------------|----------------------------------------------------|------|-----------|------|
| V <sub>CC</sub>  | Main supply voltage                                | −0.3 | 4         | V    |
| I <sub>OUT</sub> | Output current, SDA, $\overline{\text{INT}}$       | 0    | 10        | mA   |
| V <sub>OUT</sub> | Output voltage, SDA, $\overline{\text{INT}}$       | −0.3 | 7         | V    |
| V <sub>IN</sub>  | Input voltage, SCL, SDA, , $\overline{\text{INT}}$ | −0.3 | 7         | V    |
| B <sub>MAX</sub> | Magnetic flux density                              |      | Unlimited | T    |
| T <sub>J</sub>   | Junction temperature                               | −40  | 150       | °C   |
| T <sub>stg</sub> | Storage temperature                                | −65  | 170       | °C   |

- (1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

### 6.2 ESD Ratings

|                    |                         |                                                         | VALUE | UNIT |
|--------------------|-------------------------|---------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per AEC Q100-002 <sup>(1)</sup> | ±2000 | V    |
|                    |                         | Charged device model (CDM), per AEC Q100-011            | ±700  |      |
|                    |                         | Other pins                                              | ±500  |      |

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)  
over recommended V<sub>VCC</sub> range (unless otherwise noted)

|                  |                                                       | MIN | NOM | MAX | UNIT             |
|------------------|-------------------------------------------------------|-----|-----|-----|------------------|
| V <sub>VCC</sub> | Main supply voltage                                   | 2.3 |     | 3.6 | V                |
| V <sub>OUT</sub> | Output voltage, SDA, $\overline{\text{INT}}$          | 0   |     | 5.5 | V                |
| I <sub>OUT</sub> | Output current, SDA, $\overline{\text{INT}}$          |     |     | 2   | mA               |
| V <sub>IH</sub>  | Input HIGH voltage, SCL, SDA, $\overline{\text{INT}}$ | 0.7 |     |     | V <sub>VCC</sub> |
| V <sub>IL</sub>  | Input LOW voltage, SCL, SDA, $\overline{\text{INT}}$  |     |     | 0.3 | V <sub>VCC</sub> |
| T <sub>A</sub>   | Operating free air temperature                        | −40 |     | 125 | C                |

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TMAG5173-Q1   | UNIT |
|-------------------------------|----------------------------------------------|---------------|------|
|                               |                                              | DBV (6-SOT23) |      |
|                               |                                              | 6 PINS        |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 162           | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 81.6          | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 50.1          | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 30.7          | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 49.8          | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

over recommended  $V_{CC}$  range (unless otherwise noted)

| PARAMETER                 |                                                            | TEST CONDITIONS                                                                                  | MIN | TYP  | MAX       | UNIT          |
|---------------------------|------------------------------------------------------------|--------------------------------------------------------------------------------------------------|-----|------|-----------|---------------|
| <b>SDA, INT</b>           |                                                            |                                                                                                  |     |      |           |               |
| $V_{OL}$                  | Output LOW voltage, SDA, $\overline{INT}$ pin              | $I_{OUT} = 2\text{ mA}$                                                                          | 0   |      | 0.4       | V             |
| $I_{OZ}$                  | Output leakage current, SDA, $\overline{INT}$ pin          | Output disabled<br>$V_{OZ} = 5.5\text{ V}$                                                       |     |      | $\pm 100$ | nA            |
| $t_{FALL\_INT}$           | $\overline{INT}$ output fall time                          | $R_{PU} = 10\text{ k}\Omega$<br>$C_L = 20\text{ pF}$<br>$V_{PU} = 1.7\text{ V to } 5.5\text{ V}$ |     | 6    |           | ns            |
| $t_{INT}(\overline{INT})$ | $\overline{INT}$ Interrupt time duration during pulse mode | $INT\_MODE = 001b\text{ or }010b$                                                                |     | 10   |           | $\mu\text{s}$ |
| $t_{INT}(SCL)$            | SCL Interrupt time duration                                | $INT\_MODE = 011b\text{ or }100b$                                                                |     | 10   |           | $\mu\text{s}$ |
| <b>DC POWER SECTION</b>   |                                                            |                                                                                                  |     |      |           |               |
| $V_{CCUV}$                | Under voltage threshold at $V_{CC}$                        |                                                                                                  | 1.9 | 2.1  | 2.2       | V             |
| $I_{ACTIVE}$              | Active mode current                                        | X, Y, Z, or thermal sensor active conversion, $LP\_LN = 0b$                                      |     | 2.4  |           | mA            |
| $I_{ACTIVE}$              | Active mode current                                        | X, Y, Z, or thermal sensor active conversion, $LP\_LN = 1b$                                      |     | 3.0  |           | mA            |
| $I_{STANDBY}$             | Standby mode current                                       | Device in trigger mode, no conversion started                                                    |     | 0.45 |           | mA            |
| $I_{SLEEP}$               | Sleep mode current                                         |                                                                                                  |     | 8    |           | nA            |

## 6.6 Temperature Sensor

over operating free-air temperature range (unless otherwise noted)

over recommended  $V_{CC}$  range (unless otherwise noted)

| PARAMETER         |                                                        | TEST CONDITIONS                                     | MIN | TYP       | MAX       | UNIT                    |
|-------------------|--------------------------------------------------------|-----------------------------------------------------|-----|-----------|-----------|-------------------------|
| $T_{SENS\_RANGE}$ | Temperature sensing range                              |                                                     | -40 |           | 150       | $^{\circ}\text{C}$      |
| $T_{SENS}$        | Temperature output <sup>(1)</sup>                      | $T_A = 25^{\circ}\text{C}$                          | 23  | 25        | 27        | $^{\circ}\text{C}$      |
| $T_{SENS\_RES}$   | Temperature sensing resolution (in 16-bit format)      |                                                     |     | 58        |           | LSB/ $^{\circ}\text{C}$ |
| $T_{SENS\_T0}$    | Reference temperature for $T_{ADC\_T0}$                |                                                     |     | 25        |           | $^{\circ}\text{C}$      |
| $T_{ADC\_T0}$     | Temperature result in decimal value for $T_{SENS\_T0}$ |                                                     |     | 17508     |           |                         |
| $T_{SENS\_ER}$    | Temperature error <sup>(1)</sup>                       | $T_A = -40^{\circ}\text{C to } 125^{\circ}\text{C}$ |     | $\pm 0.5$ | $\pm 3.5$ | $^{\circ}\text{C}$      |
| $NRMS\_T$         | RMS (1 Sigma) temperature noise                        | $CONV\_AVG = 101b$                                  |     | 0.05      |           | $^{\circ}\text{C}$      |
| $NRMS\_T$         | RMS (1 Sigma) temperature noise                        | $CONV\_AVG = 000b$                                  |     | 0.3       |           | $^{\circ}\text{C}$      |

(1) The temperature data is collected with  $T\_CH\_EN = 1h$  and at least one magnetic channel enabled

## 6.7 Magnetic Characteristics For A1, B1, C1, D1

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                     |                                                                                                                         | TEST CONDITIONS               | MIN | TYP    | MAX    | UNIT   |
|-------------------------------|-------------------------------------------------------------------------------------------------------------------------|-------------------------------|-----|--------|--------|--------|
| B <sub>IN_A1_X_Y</sub>        | Linear magnetic range <sup>(1)</sup>                                                                                    | x_y_RANGE = 0b                |     | ±40    |        | mT     |
| B <sub>IN_A1_X_Y</sub>        |                                                                                                                         | x_y_RANGE = 1b                |     | ±80    |        | mT     |
| B <sub>IN_A1_Z</sub>          |                                                                                                                         | z_RANGE = 0b                  |     | ±40    |        | mT     |
| B <sub>IN_A1_Z</sub>          |                                                                                                                         | z_RANGE = 1b                  |     | ±80    |        | mT     |
| SENS <sub>40_A1</sub>         | Sensitivity, X, Y, or Z axis                                                                                            | ±40 mT range                  |     | 844    |        | LSB/mT |
| SENS <sub>80_A1</sub>         |                                                                                                                         | ±80 mT range                  |     | 425    |        | LSB/mT |
| SENS <sub>ER_PC_25C_A1</sub>  | Sensitivity error, X, Y, Z axis                                                                                         | T <sub>A</sub> = 25°C         |     | ±0.4%  | ±2.5%  |        |
| SENS <sub>ER_PC_TEMP_A1</sub> | Sensitivity temperature drift from 25°C value; X, Y, Z axis <sup>(2)</sup>                                              |                               |     | ±2.0%  | ±4.8%  |        |
| SENS <sub>LER_XY_A1</sub>     | Sensitivity linearity error, X, Y-axis                                                                                  | T <sub>A</sub> = 25°C         |     | ±0.10% |        |        |
| SENS <sub>LER_Z_A1</sub>      | Sensitivity linearity error, Z axis                                                                                     | T <sub>A</sub> = 25°C         |     | ±0.10% |        |        |
| SENS <sub>MS_XY_A1</sub>      | Sensitivity mismatch among X-Y axes                                                                                     | T <sub>A</sub> = 25°C         |     | ±0.40% | ±2.1%  |        |
| SENS <sub>MS_Z_A1</sub>       | Sensitivity mismatch among Y-Z, or X-Z axes                                                                             | T <sub>A</sub> = 25°C         |     | ±0.40% | ±2.0%  |        |
| SENS <sub>MS_DR_XY_A1</sub>   | Sensitivity mismatch temperature drift from 25°C value; X-Y axes <sup>(2)</sup>                                         |                               |     | ±0.4%  | ±2.0%  |        |
| SENS <sub>MS_DR_Z_A1</sub>    | Sensitivity mismatch temperature drift from 25°C value; Y-Z, or X-Z axes <sup>(2)</sup>                                 |                               |     | ±0.4%  | ±5.4%  |        |
| SENS <sub>LDR_A1</sub>        | Sensitivity lifetime drift, X, Y, Z axis                                                                                | T <sub>A</sub> = 25°C         |     | ±1.0%  | ±3.74% |        |
| B <sub>off_A1</sub>           | Offset                                                                                                                  | T <sub>A</sub> = 25°C         |     | ±100   | ±700   | μT     |
| B <sub>off_TC_A1</sub>        | Offset temperature drift from 25°C value <sup>(2)</sup>                                                                 |                               |     | ±1.2   | ±7.85  | μT/°C  |
| B <sub>off_DR_A1</sub>        | Offset lifetime drift                                                                                                   | T <sub>A</sub> = 25°C         |     | ±100   |        | μT     |
| N <sub>RMS_XY_00_000_A1</sub> | RMS (1 sigma) magnetic noise (X or Y-axis)<br>T <sub>A</sub> = 25°C                                                     | LP_LN = 0b<br>CONV_AVG = 000b |     | 92     |        | μT     |
| N <sub>RMS_XY_01_000_A1</sub> |                                                                                                                         | LP_LN = 1b<br>CONV_AVG = 000b |     | 82.5   |        | μT     |
| N <sub>RMS_XY_00_101_A1</sub> |                                                                                                                         | LP_LN = 0b<br>CONV_AVG = 101b |     | 16.75  |        | μT     |
| N <sub>RMS_XY_01_101_A1</sub> |                                                                                                                         | LP_LN = 1b<br>CONV_AVG = 101b |     | 15     |        | μT     |
| N <sub>RMS_Z_00_000_A1</sub>  | RMS (1 sigma) magnetic noise (Z axis)<br>T <sub>A</sub> = 25°C                                                          | LP_LN = 0b<br>CONV_AVG = 000b |     | 53     |        | μT     |
| N <sub>RMS_Z_01_000_A1</sub>  |                                                                                                                         | LP_LN = 1b<br>CONV_AVG = 000b |     | 48.8   |        | μT     |
| N <sub>RMS_Z_00_101_A1</sub>  |                                                                                                                         | LP_LN = 0b<br>CONV_AVG = 101b |     | 9.4    |        | μT     |
| N <sub>RMS_Z_01_101_A1</sub>  |                                                                                                                         | LP_LN = 1b<br>CONV_AVG = 101b |     | 8.6    |        | μT     |
| A <sub>ERR_X_Z_101_A1</sub>   | X-Z or Y-Z angle error in full 360-degree rotation, 40-mT range, TEMPCO = 0h, T <sub>A</sub> = 25°C <sup>(3)</sup>      | CONV_AVG = 101b               |     | ±0.4   | ±1.2   | Degree |
| A <sub>ERR_X_Y_101_A1</sub>   | X-Y angle error in full 360-degree rotation, 80-mT range, TEMPCO = 0h, T <sub>A</sub> = 25°C <sup>(3)</sup>             | CONV_AVG = 101b               |     | ±0.35  | ±1.1   | Degree |
| A <sub>DR_X_Z_101_A1</sub>    | X-Z or Y-Z angle temperature drift from 25°C value in full 360-degree rotation; 40-mT range, TEMPCO = 0h <sup>(3)</sup> | CONV_AVG = 101b               |     | ±0.9   | ±2.5   | Degree |

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                  |                                                                                                                  | TEST CONDITIONS | MIN | TYP  | MAX  | UNIT   |
|----------------------------|------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|------|--------|
| A <sub>DR_X_Y_101_A1</sub> | X-Y angle temperature drift from 25°C value in full 360-degree rotation; 80-mT range, TEMPCO = 0h <sup>(3)</sup> | CONV_AVG = 101b |     | ±0.4 | ±1.2 | Degree |

- (1) Use only up to 90% of the linear magnetic range in the application
- (2) Temperature drift is specified for full operating temperature range of –40°C to 125°C. Drift at an intermediate temperature can be estimated using the following examples: drift at 85°C = ((85 – 25) / (125 – 25)) × (drift); similarly, drift at –20°C = ((25 – (–20)) / (25 – (–40))) × (drift).
- (3) Angle calculation is performed on-axis after calibrating system mechanical errors including magnet tilt and magnet misalignment.

## 6.8 Magnetic Characteristics For A2, B2, C2, D2

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                     |                                                                                         | TEST CONDITIONS               | MIN | TYP    | MAX   | UNIT   |
|-------------------------------|-----------------------------------------------------------------------------------------|-------------------------------|-----|--------|-------|--------|
| B <sub>IN_A2_X_Y</sub>        | Linear magnetic range <sup>(1)</sup>                                                    | x_y_RANGE = 0b                |     | ±133   |       | mT     |
| B <sub>IN_A2_X_Y</sub>        |                                                                                         | x_y_RANGE = 1b                |     | ±266   |       | mT     |
| B <sub>IN_A2_Z</sub>          |                                                                                         | z_RANGE = 0b                  |     | ±133   |       | mT     |
| B <sub>IN_A2_Z</sub>          |                                                                                         | z_RANGE = 1b                  |     | ±266   |       | mT     |
| SENS <sub>133_A2</sub>        | Sensitivity, X, Y, or Z axis                                                            | ±133 mT range                 |     | 263    |       | LSB/mT |
| SENS <sub>266_A2</sub>        |                                                                                         | ±266 mT range                 |     | 132    |       | LSB/mT |
| SENS <sub>ER_PC_25C_A2</sub>  | Sensitivity error, X, Y, Z axis                                                         | T <sub>A</sub> = 25°C         |     | ±0.8%  | ±3.3% |        |
| SENS <sub>ER_PC_TEMP_A2</sub> | Sensitivity temperature drift from 25°C value; X, Y, Z axis <sup>(1)</sup>              |                               |     | ±3.0%  | ±5.5% |        |
| SENS <sub>LER_XY_A2</sub>     | Sensitivity linearity error, X, Y-axis                                                  | T <sub>A</sub> = 25°C         |     | ±0.10% |       |        |
| SENS <sub>LER_Z_A2</sub>      | Sensitivity linearity error, Z axis                                                     | T <sub>A</sub> = 25°C         |     | ±0.10% |       |        |
| SENS <sub>MS_XY_A2</sub>      | Sensitivity mismatch among X-Y axes                                                     | T <sub>A</sub> = 25°C         |     | ±0.5%  | ±2.3% |        |
| SENS <sub>MS_Z_A2</sub>       | Sensitivity mismatch among Y-Z, or X-Z axes                                             | T <sub>A</sub> = 25°C         |     | ±1.50% | ±4.3% |        |
| SENS <sub>MS_DR_XY_A2</sub>   | Sensitivity mismatch temperature drift from 25°C value; X-Y axes <sup>(2)</sup>         |                               |     | ±0.5%  | ±2.0% |        |
| SENS <sub>MS_DR_Z_A2</sub>    | Sensitivity mismatch temperature drift from 25°C value; Y-Z, or X-Z axes <sup>(2)</sup> |                               |     | ±4.5%  | ±8.0% |        |
| SENS <sub>LDR_A2</sub>        | Sensitivity lifetime drift, X, Y, Z axis                                                | T <sub>A</sub> = 25°C         |     | ±1.5%  | ±4.9% |        |
| B <sub>off_A2</sub>           | Offset                                                                                  | T <sub>A</sub> = 25°C         |     | ±100   | ±700  | μT     |
| B <sub>off_TC_A2</sub>        | Offset temperature drift from 25°C value <sup>(2)</sup>                                 |                               |     | ±1.2   | ±7.0  | μT/°C  |
| B <sub>off_DR_A2</sub>        | Offset lifetime drift                                                                   | T <sub>A</sub> = 25°C         |     | ±100   |       | μT     |
| N <sub>RMS_XY_00_000_A2</sub> | RMS (1 sigma) magnetic noise (X or Y-axis)                                              | LP_LN = 0b<br>CONV_AVG = 000b |     | 113    |       | μT     |
| N <sub>RMS_XY_01_000_A2</sub> |                                                                                         | LP_LN = 1b<br>CONV_AVG = 000b |     | 105    |       | μT     |
| N <sub>RMS_XY_00_010_A2</sub> |                                                                                         | LP_LN = 0b<br>CONV_AVG = 101b |     | 20     |       | μT     |
| N <sub>RMS_XY_10_010_A2</sub> |                                                                                         | LP_LN = 1b<br>CONV_AVG = 101b |     | 18.6   |       | μT     |
| N <sub>RMS_Z_00_000_A2</sub>  | RMS (1 sigma) magnetic noise (Z axis)                                                   | LP_LN = 0b<br>CONV_AVG = 000b |     | 81.7   |       | μT     |
| N <sub>RMS_Z_10_000_A2</sub>  |                                                                                         | LP_LN = 1b<br>CONV_AVG = 000b |     | 78.4   |       | μT     |
| N <sub>RMS_Z_00_101_A2</sub>  |                                                                                         | LP_LN = 0b<br>CONV_AVG = 101b |     | 13.9   |       | μT     |
| N <sub>RMS_Z_10_101_A2</sub>  |                                                                                         | LP_LN = 1b<br>CONV_AVG = 101b |     | 14     |       | μT     |

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                   |                                                                                                                          | TEST CONDITIONS | MIN | TYP   | MAX  | UNIT   |
|-----------------------------|--------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-------|------|--------|
| A <sub>ERR_X_Z_101_A2</sub> | X-Z or Y-Z angle error in full 360-degree rotation; TEMPCO = 0h, T <sub>A</sub> = 25°C <sup>(3)</sup>                    | CONV_AVG = 101b |     | ±0.25 | ±1.0 | Degree |
| A <sub>ERR_X_Y_101_A2</sub> | X-Y angle error in full 360-degree rotation; 133-mT range, TEMPCO = 0h, T <sub>A</sub> = 25°C <sup>(3)</sup>             | CONV_AVG = 101b |     | ±0.4  | ±1.6 | Degree |
| A <sub>DR_X_Z_101_A2</sub>  | X-Z or Y-Z angle temperature drift from 25°C value in full 360-degree rotation; 133-mT range, TEMPCO = 0h <sup>(3)</sup> | CONV_AVG = 101b |     | ±1.6  | ±2.9 | Degree |
| A <sub>DR_X_Y_101_A2</sub>  | X-Y angle temperature drift from 25°C value in full 360-degree rotation; 133-mT range, TEMPCO = 0h <sup>(3)</sup>        | CONV_AVG = 101b |     | ±0.4  | ±1.4 | Degree |

- (1) Use only up to 90% of the linear magnetic range in the application
- (2) Temperature drift is specified for full operating temperature range of –40°C to 125°C. Drift at an intermediate temperature can be estimated using the following examples: drift at 85°C = ((85 – 25) / (125 – 25)) × (drift); similarly, drift at –20°C = ((25 – (–20)) / (25 – (–40))) × (drift).
- (3) Angle calculation is performed on-axis after calibrating system mechanical errors including magnet tilt and magnet misalignment.

## 6.9 Magnetic Temp Compensation Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER         |                                         | TEST CONDITIONS | MIN | TYP  | MAX | UNIT |
|-------------------|-----------------------------------------|-----------------|-----|------|-----|------|
| TC <sub>_00</sub> | Temperature compensation (X, Y, Z-axes) | TEMPCO = 00b    |     | 0    |     | %/°C |
| TC <sub>_12</sub> |                                         | TEMPCO = 01b    |     | 0.12 |     | %/°C |
| TC <sub>_03</sub> |                                         | TEMPCO = 10b    |     | 0.03 |     | %/°C |
| TC <sub>_20</sub> |                                         | TEMPCO = 11b    |     | 0.2  |     | %/°C |

## 6.10 I<sup>2</sup>C Interface Timing

minimum and maximum specifications are over  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  and  $V_{\text{CC}} = 2.3\text{ V}$  to  $3.6\text{ V}$  (unless otherwise noted)<sup>(1)</sup>

|                      |                                                                                               | FAST MODE                             |     | FAST MODE PLUS                        |      | UNIT          |
|----------------------|-----------------------------------------------------------------------------------------------|---------------------------------------|-----|---------------------------------------|------|---------------|
|                      |                                                                                               | MIN                                   | MAX | MIN                                   | MAX  |               |
| $f_{\text{(SCL)}}$   | SCL operating frequency                                                                       | 1                                     | 400 | 1                                     | 1000 | kHz           |
| $t_{\text{(BUF)}}$   | Bus-free time between STOP and START conditions                                               | 1.3                                   |     | 0.5                                   |      | $\mu\text{s}$ |
| $t_{\text{(SUSTA)}}$ | Repeated START condition setup time                                                           | 0.6                                   |     | 0.26                                  |      | $\mu\text{s}$ |
| $t_{\text{(HDSTA)}}$ | Hold time after repeated START condition.<br>After this period, the first clock is generated. | 0                                     |     | 0                                     |      | $\mu\text{s}$ |
| $t_{\text{(SUSTO)}}$ | STOP condition setup time                                                                     | 0.6                                   |     | 0.26                                  |      | $\mu\text{s}$ |
| $t_{\text{(HDDAT)}}$ | Data hold time <sup>(2)</sup>                                                                 | 0                                     | 900 | 0                                     | 150  | ns            |
| $t_{\text{(SUDAT)}}$ | Data setup time                                                                               | 100                                   |     | 50                                    |      | ns            |
| $t_{\text{(LOW)}}$   | SCL clock low period                                                                          | 1.3                                   |     | 0.5                                   |      | $\mu\text{s}$ |
| $t_{\text{(HIGH)}}$  | SCL clock high period                                                                         | 0.6                                   |     | 0.26                                  |      | $\mu\text{s}$ |
| $t_{\text{R}}$       | SDA, SCL fall time                                                                            | 20                                    | 300 |                                       | 120  | ns            |
| $t_{\text{F}}$       | SDA, SCL fall time                                                                            | 20 x<br>( $V_{\text{CC}} / 5.5$<br>V) | 300 | 20 x<br>( $V_{\text{CC}} / 5.5$<br>V) | 120  | ns            |
| $t_{\text{LPF}}$     | Glitch suppression filter                                                                     | 50                                    |     | 50                                    |      | ns            |

(1) The host and device have the same  $V_{\text{CC}}$  value. Values are based on statistical analysis of samples tested during initial release.

(2) The maximum  $t_{\text{(HDDAT)}}$  can be  $0.9\text{ }\mu\text{s}$  for fast mode, and is less than the maximum  $t_{\text{(VDAT)}}$  by a transition time.

## 6.11 Power up Timing

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                     |                                                                                               | TEST CONDITIONS                                                       | MIN | TYP | MAX | UNIT          |
|-------------------------------|-----------------------------------------------------------------------------------------------|-----------------------------------------------------------------------|-----|-----|-----|---------------|
| $t_{\text{start\_power\_up}}$ | Time to go to standby mode after $V_{\text{CC}}$ supply voltage crossing $V_{\text{CC\_MIN}}$ |                                                                       |     | 270 |     | $\mu\text{s}$ |
| $t_{\text{start\_sleep}}$     | Time to go to standby mode from sleep mode <sup>(1)</sup>                                     |                                                                       |     | 50  |     | $\mu\text{s}$ |
| $t_{\text{start\_measure}}$   | Time to go into continuous measure mode from standby mode                                     |                                                                       |     | 70  |     | $\mu\text{s}$ |
| $t_{\text{measure}}$          | Conversion time                                                                               | CONV_AVG = 000b,<br>OPERATING_MODE = 10b,<br>only one channel enabled |     | 50  |     | $\mu\text{s}$ |
| $t_{\text{measure}}$          | Conversion time                                                                               | CONV_AVG = 101b,<br>OPERATING_MODE = 10b,<br>only one channel enabled |     | 825 |     | $\mu\text{s}$ |
| $t_{\text{go\_sleep}}$        | Time to go into sleep mode after SCL goes high                                                |                                                                       |     | 20  |     | $\mu\text{s}$ |

(1) The device will recognize the I2C communication from a primary only during standby or continuous measure modes. While the device is in sleep mode, a valid secondary address will wake up the device but no acknowledge will be sent to the primary. Start up time need to be considered before addressing the device after wake up.

## 6.12 Timing Diagram

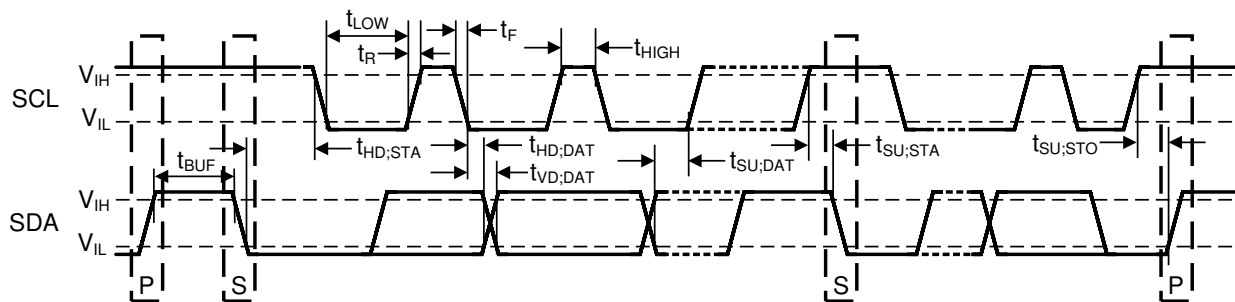


Figure 6-1. I2C Timing Diagram

## 6.13 Typical Characteristics

at  $T_A = 25^\circ\text{C}$  typical (unless otherwise noted)

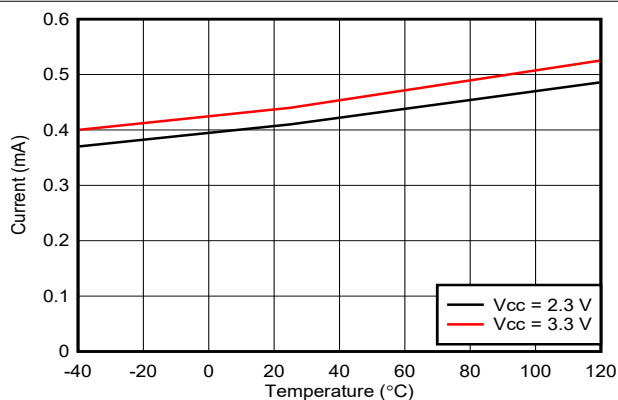


Figure 6-2. Standby Mode ICC vs Temperature

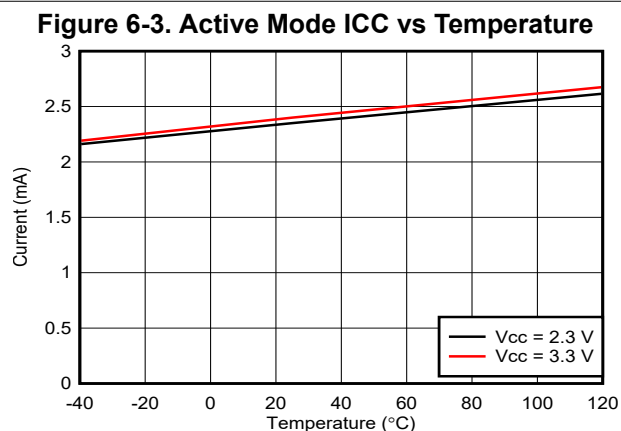


Figure 6-3. Active Mode ICC vs Temperature

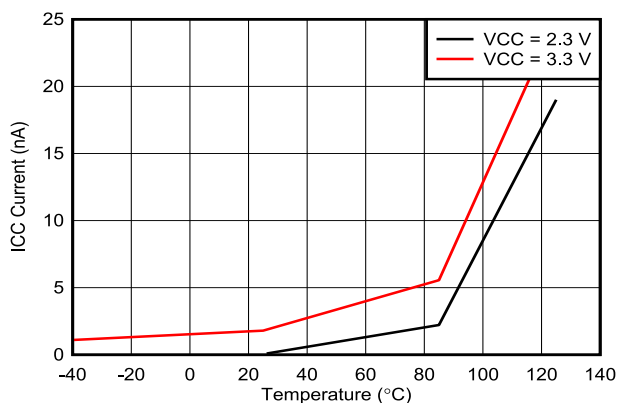


Figure 6-4. Sleep Mode ICC vs Temperature

## 7 Detailed Description

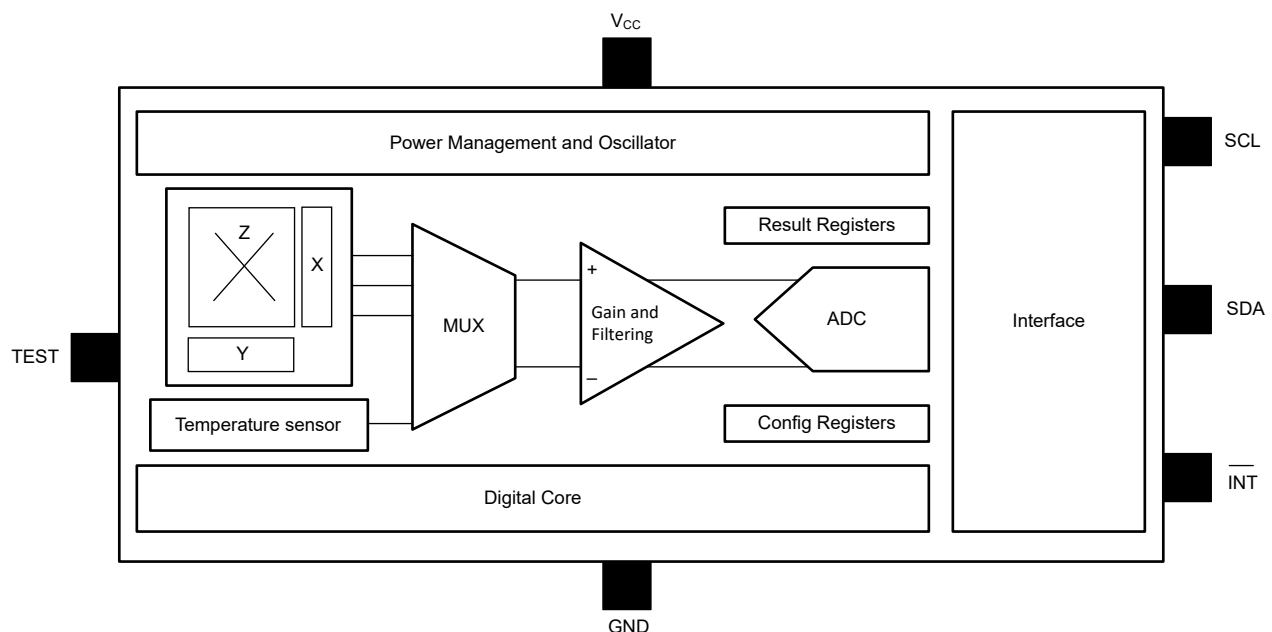
### 7.1 Overview

The TMAG5173-Q1 IC is based on the Hall-effect technology and precision mixed signal circuitry from Texas Instruments. The output signals (raw X, Y, Z magnetic data and temperature data) are accessible through the I<sup>2</sup>C interface.

The IC consists of the following functional and building blocks:

- The Power Management & Oscillator block contain a low-power oscillator, biasing circuitry, undervoltage detection circuitry, and a fast oscillator.
- The sensing and temperature measurement block contains the Hall biasing, Hall sensors with multiplexers, noise filters, integrator circuit, temperature sensor, and the ADC. The Hall-effect sensor data and temperature data are multiplexed through the same ADC.
- The Interface block contains the I<sup>2</sup>C control circuitry, ESD protection circuits, and all the I/O circuits. The TMAG5173-Q1 supports multiple I<sup>2</sup>C read frames along with integrated cyclic redundancy check (CRC).

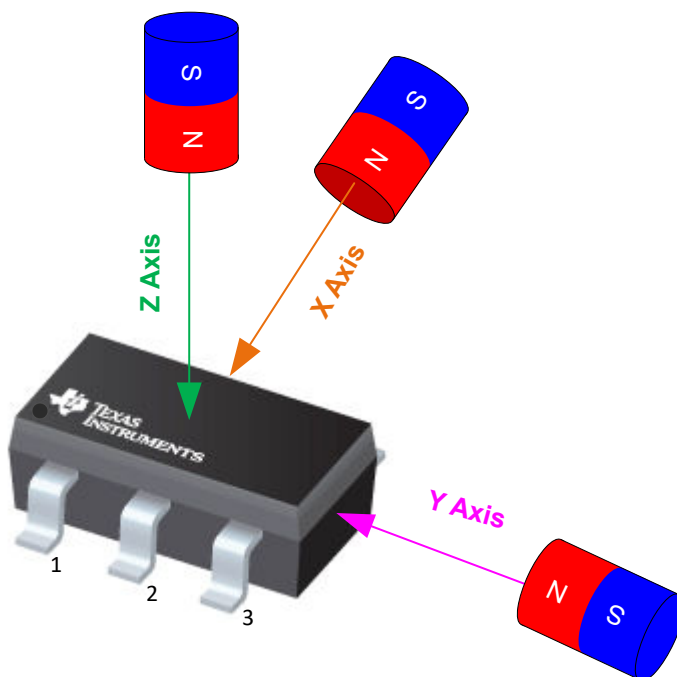
### 7.2 Functional Block Diagram



## 7.3 Feature Description

### 7.3.1 Magnetic Flux Direction

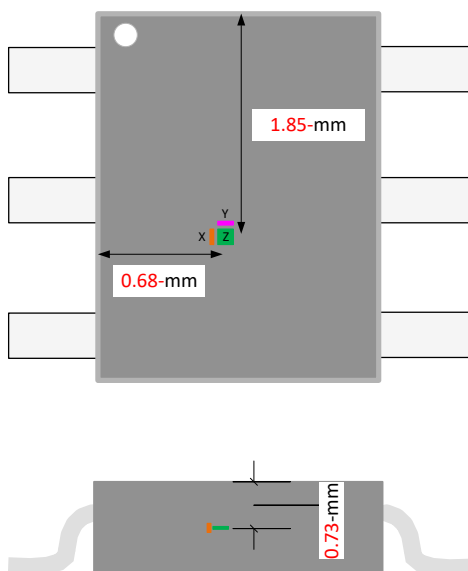
As shown in Figure 7-1, the TMAG5173-Q1 will generate positive ADC codes in response to a magnetic north pole in the proximity. Similarly, the TMAG5173-Q1 will generate negative ADC codes if magnetic south poles approach from the same directions.



**Figure 7-1. Direction of Sensitivity**

### 7.3.2 Sensor Location

Figure 7-2 shows the location of X, Y, Z hall elements inside the TMAG5173-Q1.



**Figure 7-2. Location of X, Y, Z Hall Elements**

### 7.3.3 Interrupt Function

The TMAG5173-Q1 supports flexible and configurable interrupt functions through either the  $\overline{\text{INT}}$  or the SCL pin. Table 7-1 shows different conversion completion events where result registers and SET\_COUNT bits update, and where they do not.

**Table 7-1. Result Register & SET\_COUNT Update After Conversion Completion**

| INT_MODE | MODE DESCRIPTION                                                            | I <sup>2</sup> C BUS BUSY, NOT TALKING TO DEVICE |                   | I <sup>2</sup> C BUS BUSY & TALKING TO DEVICE |                   | I <sup>2</sup> C BUS NOT BUSY |                   |
|----------|-----------------------------------------------------------------------------|--------------------------------------------------|-------------------|-----------------------------------------------|-------------------|-------------------------------|-------------------|
|          |                                                                             | RESULT UPDATE?                                   | SET_COUNT UPDATE? | RESULT UPDATE?                                | SET_COUNT UPDATE? | RESULT UPDATE?                | SET_COUNT UPDATE? |
| 000b     | No interrupt                                                                | Yes                                              | Yes               | No                                            | No                | Yes                           | Yes               |
| 001b     | Interrupt through $\overline{\text{INT}}$                                   | Yes                                              | Yes               | No                                            | No                | Yes                           | Yes               |
| 010b     | Interrupt through $\overline{\text{INT}}$ except when I <sup>2</sup> C busy | Yes                                              | Yes               | No                                            | No                | Yes                           | Yes               |
| 011b     | Interrupt through SCL                                                       | Yes                                              | Yes               | No                                            | No                | Yes                           | Yes               |
| 100b     | Interrupt through SCL except when I <sup>2</sup> C busy                     | No                                               | No                | No                                            | No                | Yes                           | Yes               |

#### Note

TI does not recommend sharing the same I<sup>2</sup>C bus with multiple secondary devices when using the SCL pin for interrupt function. The SCL interrupt may corrupt transactions with other secondary devices if present in the same I<sup>2</sup>C bus.

### 7.3.3.1 Interrupt Through SCL

Figure 7-3 shows an example for interrupt function through the SCL pin with the device programmed to generate interrupt at magnetic threshold cross event. When the magnetic threshold cross is detected, the device asserts a fixed width interrupt signal through the SCL pin.

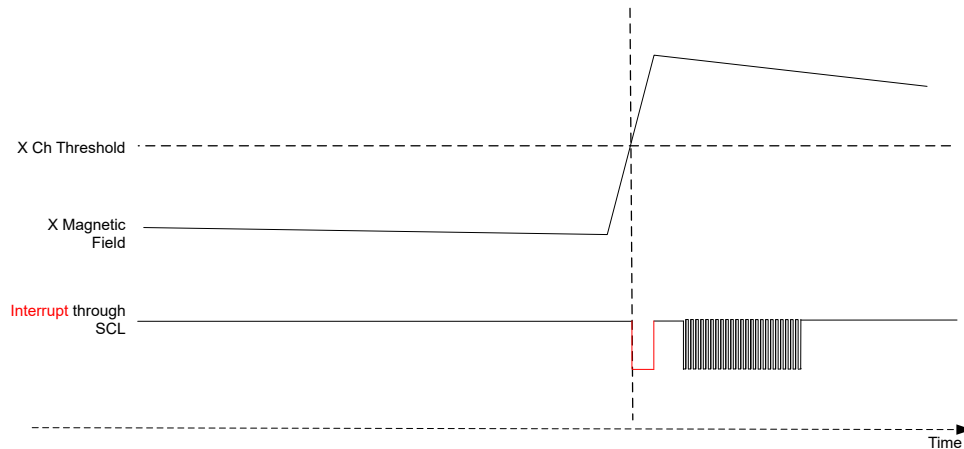


Figure 7-3. Interrupt Through SCL

### 7.3.3.2 Fixed Width Interrupt Through $\overline{\text{INT}}$

Figure 7-4 shows an example for fixed-width interrupt function through the  $\overline{\text{INT}}$  pin. The device is programmed to generate interrupt at magnetic threshold cross event. The INT\_STATE register bit is set 1b. When the magnetic threshold cross is detected, the device asserts a fixed width interrupt signal through the  $\overline{\text{INT}}$  pin.

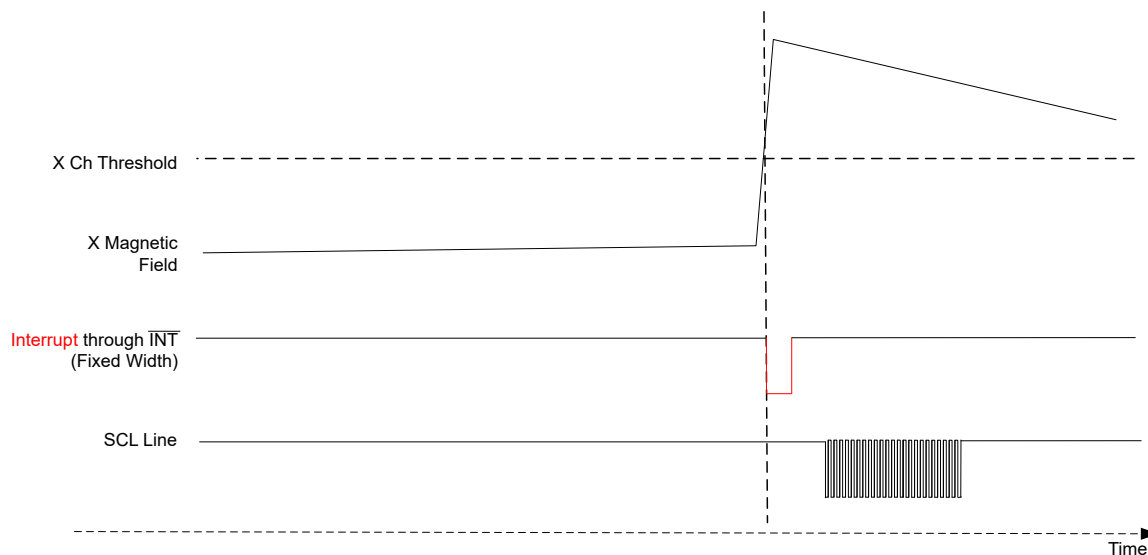
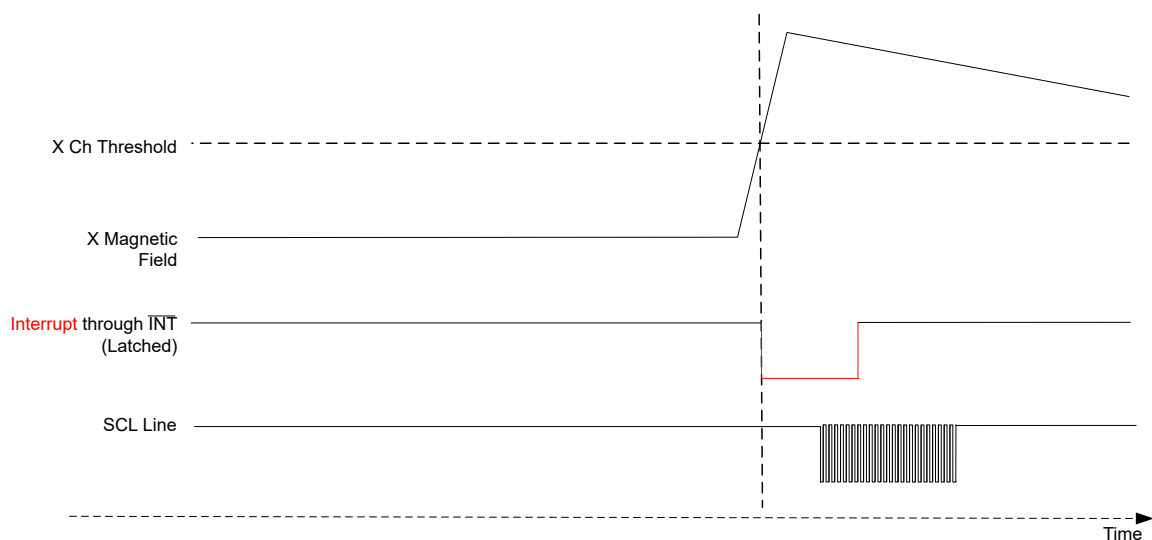


Figure 7-4. Fixed Width Interrupt Through  $\overline{\text{INT}}$

### 7.3.3.3 Latched Interrupt Through $\overline{\text{INT}}$

Figure 7-5 shows an example for latched interrupt function through the  $\overline{\text{INT}}$  pin. The device is programmed to generate interrupt at magnetic threshold cross event. The INT\_STATE register bit is set 0b. When the magnetic threshold cross is detected, the device asserts a latched interrupt signal through the  $\overline{\text{INT}}$  pin. The latched interrupt is cleared only after the device receives a valid address through the SCL line.

Figure 7-5. Latched Interrupt Through  $\overline{\text{INT}}$ 

### 7.3.4 Device I<sup>2</sup>C Address

Table 7-2 shows the default factory programmed I<sup>2</sup>C addresses of the TMAG5173-Q1. The device needs to be addressed with the factory default I<sup>2</sup>C address after power up. If required, a primary can assign a new I<sup>2</sup>C address through the I2C\_ADDRESS register bits after power up.

Table 7-2. I<sup>2</sup>C Default Address

| DEVICE VERSION | MAGNETIC RANGE             | I <sup>2</sup> C ADDRESS (7 MSB BITS) | I <sup>2</sup> C WRITE ADDRESS (8-BIT) | I <sup>2</sup> C READ ADDRESS (8-BIT) |
|----------------|----------------------------|---------------------------------------|----------------------------------------|---------------------------------------|
| TMAG5173A1     | $\pm 40$ mT, $\pm 80$ mT   | 35h                                   | 6Ah                                    | 6Bh                                   |
| TMAG5173B1     |                            | 22h                                   | 44h                                    | 45h                                   |
| TMAG5173C1     |                            | 78h                                   | F0h                                    | F1h                                   |
| TMAG5173D1     |                            | 44h                                   | 88h                                    | 89h                                   |
| TMAG5173A2     | $\pm 133$ mT, $\pm 266$ mT | 35h                                   | 6Ah                                    | 6Bh                                   |
| TMAG5173B2     |                            | 22h                                   | 44h                                    | 45h                                   |
| TMAG5173C2     |                            | 78h                                   | F0h                                    | F1h                                   |
| TMAG5173D2     |                            | 44h                                   | 88h                                    | 89h                                   |

### 7.3.5 Magnetic Range Selection

Table 7-3 shows the magnetic range selection for the TMAG5173-Q1 device. The X, Y, and Z axes range can be selected with the X\_Y\_RANGE and Z\_RANGE register bits.

**Table 7-3. Magnetic Range Selection**

|                 | RANGE REGISTER SETTING | TMAG5173A1 | TMAG5173A2 | COMMENT                |
|-----------------|------------------------|------------|------------|------------------------|
| X, Y Axis Field | X_Y_RANGE = 0b         | ±40 mT     | ±133 mT    |                        |
|                 | X_Y_RANGE = 1b         | ±80 mT     | ±266 mT    | Better SNR performance |
| Z Axis Field    | Z_RANGE = 0b           | ±40 mT     | ±133 mT    |                        |
|                 | Z_RANGE = 1b           | ±80 mT     | ±266 mT    | Better SNR performance |

### 7.3.6 Update Rate Settings

The TMAG5173-Q1 offers multiple update rates to offer design flexibility to system designers. The different update rates can be selected with the CONV\_AVG register bits. Table 7-4 shows different update rate settings for the TMAG5173-Q1.

**Table 7-4. Update Rate Settings**

| OPERATING MODE | REGISTER SETTING | UPDATE RATE |           |            | COMMENT             |
|----------------|------------------|-------------|-----------|------------|---------------------|
|                |                  | SINGLE AXIS | TWO AXES  | THREE AXES |                     |
| X, Y, Z Axis   | CONV_AVG = 000b  | 20.0 kSPS   | 13.3 kSPS | 10.0 kSPS  | Fastest update rate |
| X, Y, Z Axis   | CONV_AVG = 001b  | 13.3 kSPS   | 8.0 kSPS  | 5.7 kSPS   |                     |
| X, Y, Z Axis   | CONV_AVG = 010b  | 8.0 kSPS    | 4.4 kSPS  | 3.1 kSPS   |                     |
| X, Y, Z Axis   | CONV_AVG = 011b  | 4.4 kSPS    | 2.4 kSPS  | 1.6 kSPS   |                     |
| X, Y, Z Axis   | CONV_AVG = 100b  | 2.4 kSPS    | 1.2 kSPS  | 0.8 kSPS   |                     |
| X, Y, Z Axis   | CONV_AVG = 101b  | 1.2 kSPS    | 0.6 kSPS  | 0.4 kSPS   | Best SNR case       |

## 7.4 Device Functional Modes

The TMAG5173-Q1 supports multiple functional modes for wide array of applications as explained in [Figure 7-6](#). A specific functional mode is selected by setting the corresponding value in the OPERATING\_MODE register bits. The device starts powering up after VCC supply crosses the minimum threshold as specified in the *Recommended Operating Conditions* (ROC) table.

### 7.4.1 Standby (Trigger) Mode

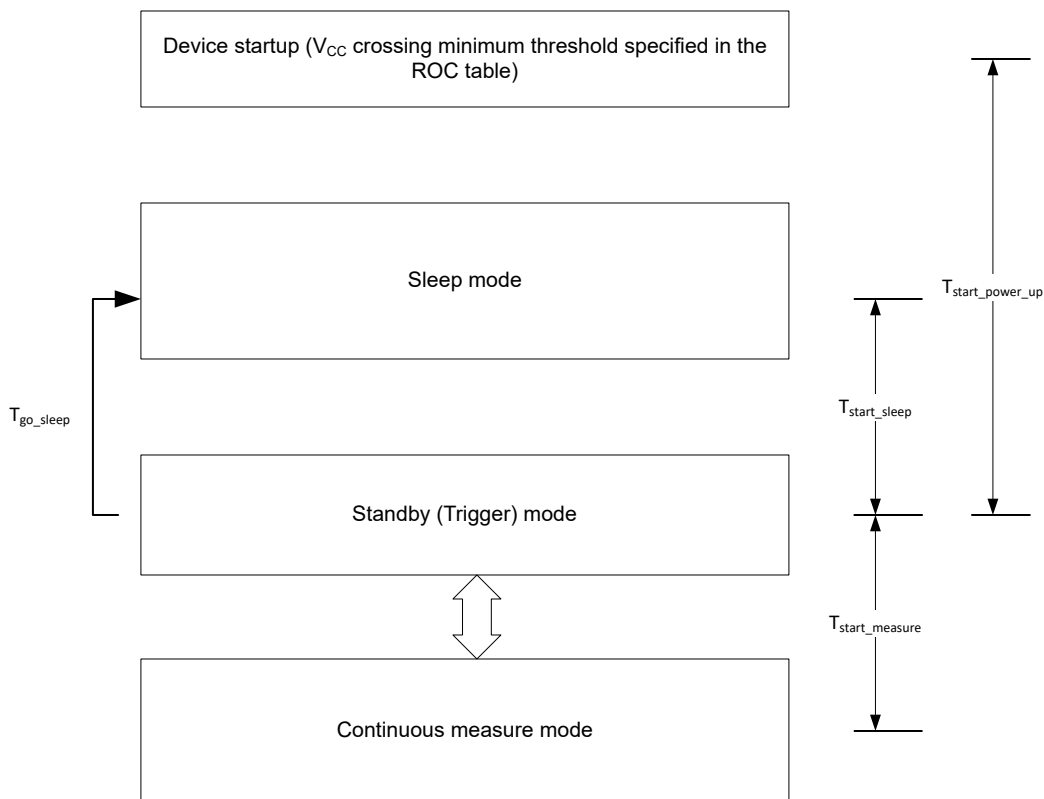
The TMAG5173-Q1 goes to standby mode after power up. During this mode the digital circuitry and oscillators are on and the device is ready to accept commands from the microcontroller. Based off the commands the device can start a new conversion, go to power saving mode, or the start data transfer through I<sup>2</sup>C interface. A new conversion can be triggered through I<sup>2</sup>C command or through  $\overline{\text{INT}}$  pin. In this mode the device retains the immediate past conversion result data in the corresponding result registers. The time it takes for the device to go to standby mode from power up is denoted by  $T_{\text{start\_power\_up}}$ . The  $\overline{\text{INT}}$  pin can be used to a trigger a new conversion or generate interrupt for the microcontroller. It is not recommended to use both functions through  $\overline{\text{INT}}$  pin simultaneously.

### 7.4.2 Sleep Mode

The TMAG5173-Q1 supports an ultra-low power sleep mode where it retains the critical user configuration settings. In this mode the device doesn't retain the conversion result data. A microcontroller can wake up the device from sleep mode to standby mode through I<sup>2</sup>C communications or the  $\overline{\text{INT}}$  pin. The time it takes for the device to go to standby mode from sleep mode is denoted by  $T_{\text{start\_sleep}}$ .

### 7.4.3 Continuous Measure Mode

In this mode the TMAG5173-Q1 continuously measures the sensor data per SENSOR\_CONFIG & DEVICE\_CONFIG register settings. In this mode the result registers can be accessed through the I2C lines. The time it takes for the device to go from standby mode to continuous measure mode is denoted by  $T_{\text{start\_measure}}$ .



**Figure 7-6. TMAG5173-Q1 Operating Modes**

Figure 7-6 shows TMAG5173-Q1 operating modes and time references to transition from one mode to another.

**Table 7-5. Operating Modes**

| OPERATING MODE          | DEVICE FUNCTION                                                                    | ACCESS TO USER REGISTERS | RETAIN USER CONFIGURATION |
|-------------------------|------------------------------------------------------------------------------------|--------------------------|---------------------------|
| Continuous measure mode | Continuously measuring X, Y, Z axes, or temperature data                           | Yes                      | Yes                       |
| Standby mode            | Device is ready to accept I <sup>2</sup> C commands and start active conversion    | Yes                      | Yes                       |
| Sleep mode              | Device retains key configuration settings, but doesn't retain the measurement data | No                       | Yes                       |

## 7.5 Programming

### 7.5.1 I<sup>2</sup>C Interface

The TMAG5173-Q1 offers I<sup>2</sup>C interface, a two-wire interface to connect low-speed devices like microcontrollers, A/D and D/A converters, I/O interfaces and other similar peripherals in embedded systems.

#### 7.5.1.1 SCL

The SCL is the clock line used to synchronize all data transfers over the I<sup>2</sup>C bus.

#### 7.5.1.2 SDA

SDA is the bidirectional data line for the I<sup>2</sup>C interface.

#### 7.5.1.3 I<sup>2</sup>C Read/Write

The TMAG5173-Q1 supports multiple I<sup>2</sup>C read and write frames targeting different applications. I2C\_RD and CRC\_EN bits offers multiple read frames to optimize the read time, data resolution, and data integrity for a select application.

##### 7.5.1.3.1 Standard I<sup>2</sup>C Write

Figure 7-7 shows an example of standard I<sup>2</sup>C two byte write command supported by TMAG5173-Q1. The starting byte contains 7-bit secondary device address and a '0' at the R/W command bit. The MSB of the second byte contains the conversion trigger bit. Writing '1' at this trigger bit will start a new conversion after the register address decoding is completed. The 7 LSB bits of the second byte contains the starting register address for the write command. After the two command bytes, the primary device starts to send the data to be written at the corresponding register address. Each successive write byte will send the data for the successive register address in the secondary device.

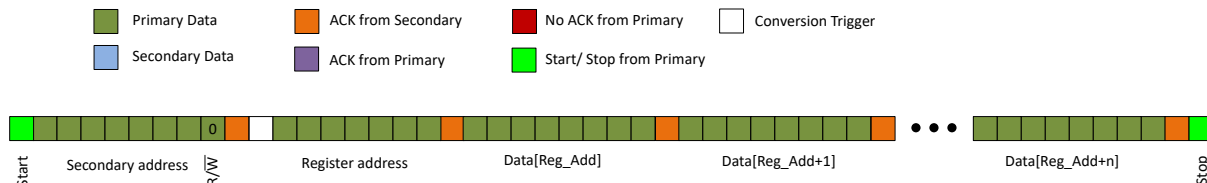


Figure 7-7. Standard I<sup>2</sup>C Write

##### 7.5.1.3.2 General Call Write

Figure 7-8 shows an example of the general call I<sup>2</sup>C write command supported by the TMAG5173-Q1. This command is useful to configure multiple I<sup>2</sup>C devices in a I<sup>2</sup>C bus simultaneously. The starting byte contains 8-bit '0's. The MSB of the second byte contains the conversion trigger bit. Writing '1' at this trigger bit will start a new conversion after the register address decoding is completed. The 7 LSB bits of the second byte contains the starting register address for the write command. After the two command bytes, the primary device starts to send the data to be written at the corresponding register address of all the secondary devices in the I<sup>2</sup>C bus. Each successive write byte will send the data for the successive register address in the secondary devices.

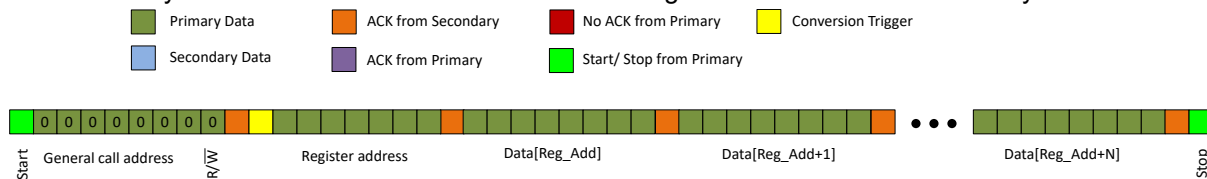


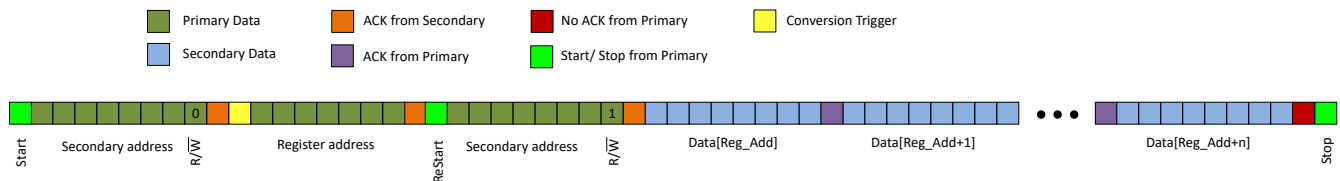
Figure 7-8. General Call I<sup>2</sup>C Write

### 7.5.1.3.3 Standard 3-Byte I<sup>2</sup>C Read

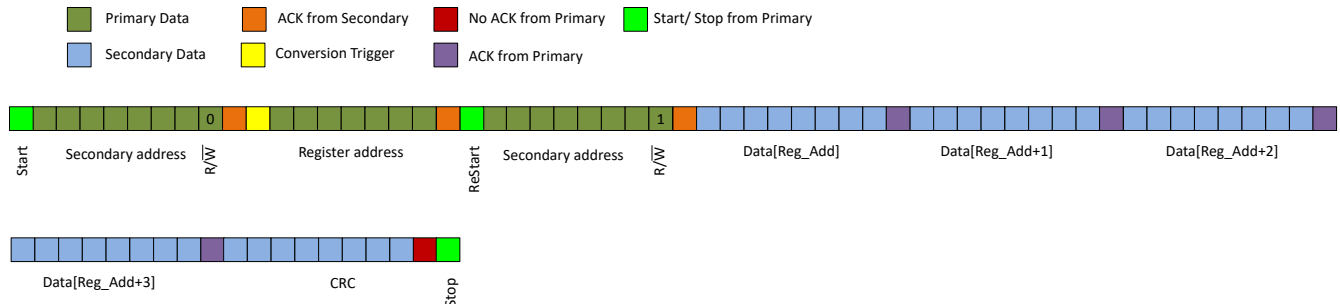
Figure 7-9 and Figure 7-10 show examples of standard I<sup>2</sup>C three byte read command supported by the TMA5173-Q1. The starting byte contains 7-bit secondary device address and the R/W command bit '0'. The MSB of the second byte contains the conversion trigger command bit. Writing '1' at this trigger bit will start a new conversion after the register address decoding is completed. The 7 LSB bits of the second byte contains the starting register address for the write command. After receiving ACK signal from secondary, the primary send the secondary address once again with R/W command bit as '1'. The secondary starts to send the corresponding register data. It will send successive register data with each successive ACK from primary. If CRC is enabled, the secondary will send the fifth CRC byte based off the CRC calculation of immediate past 4 register bytes.

#### Note

In the standard 3-byte read command the TMA5173-Q1 doesn't support CRC if the data length is more than 4 byte. Initiate successive read commands for larger data stream requiring CRC.



**Figure 7-9. Standard 3-Byte I<sup>2</sup>C Read With CRC Disabled, CRC\_EN = 0b**



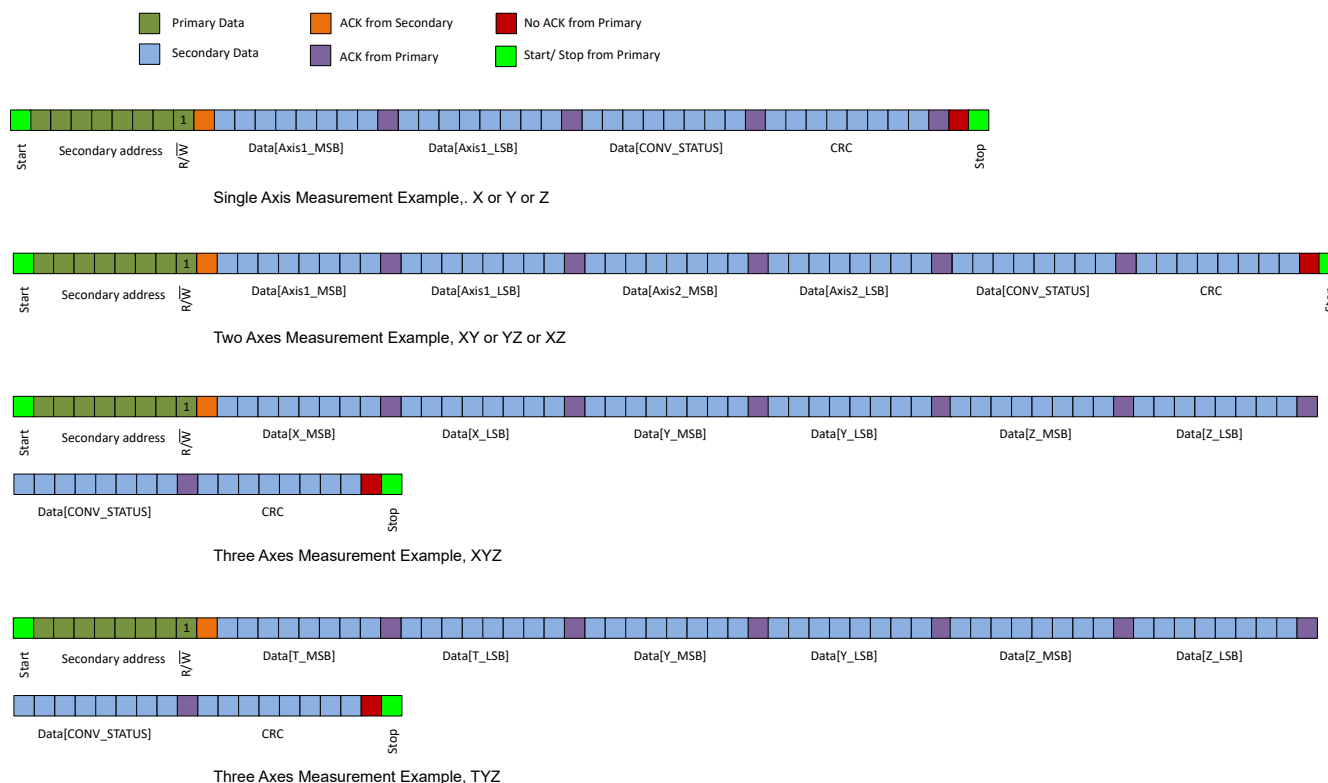
**Figure 7-10. Standard 3-Byte I<sup>2</sup>C Read With CRC Enabled, CRC\_EN = 1b**

### 7.5.1.3.4 1-Byte I<sup>2</sup>C Read Command for 16-Bit Data

Figure 7-11 and Figure 7-12 show examples of 1-byte I<sup>2</sup>C read command supported by the TMA5173-Q1. Select I2C\_RD = 01b to enable this mode. The command byte contains 7-bit secondary device address and a '1' at the R/W bit. In this mode, per MAG\_CH\_EN and T\_CH\_EN bits setting, the device will send 16-bit data of the enabled channels and the CONV\_STATUS register data byte. If CRC is enabled, the device will send an additional CRC byte based off the CRC calculation of the command byte and the data sent in the current packet. When multiple channels are enabled, the sent data follows the T, X, Y, and Z sequence in the successive data bytes.



**Figure 7-11. 1-Byte I<sup>2</sup>C Read Command for 16-Bit Data With CRC Disabled, CRC\_EN = 0b**



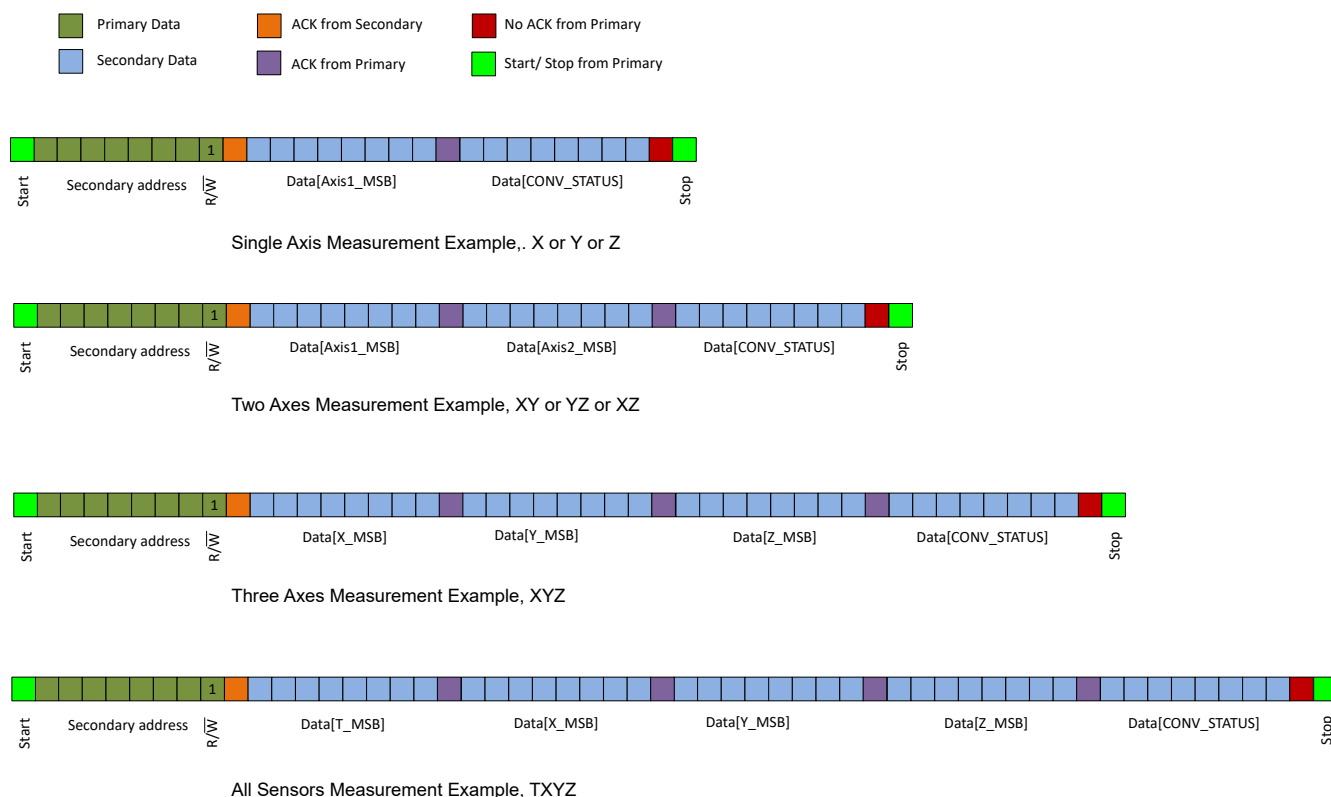
**Figure 7-12. 1-Byte I<sup>2</sup>C Read Command for 16-Bit Data With CRC Enabled, CRC\_EN = 1b**

### Note

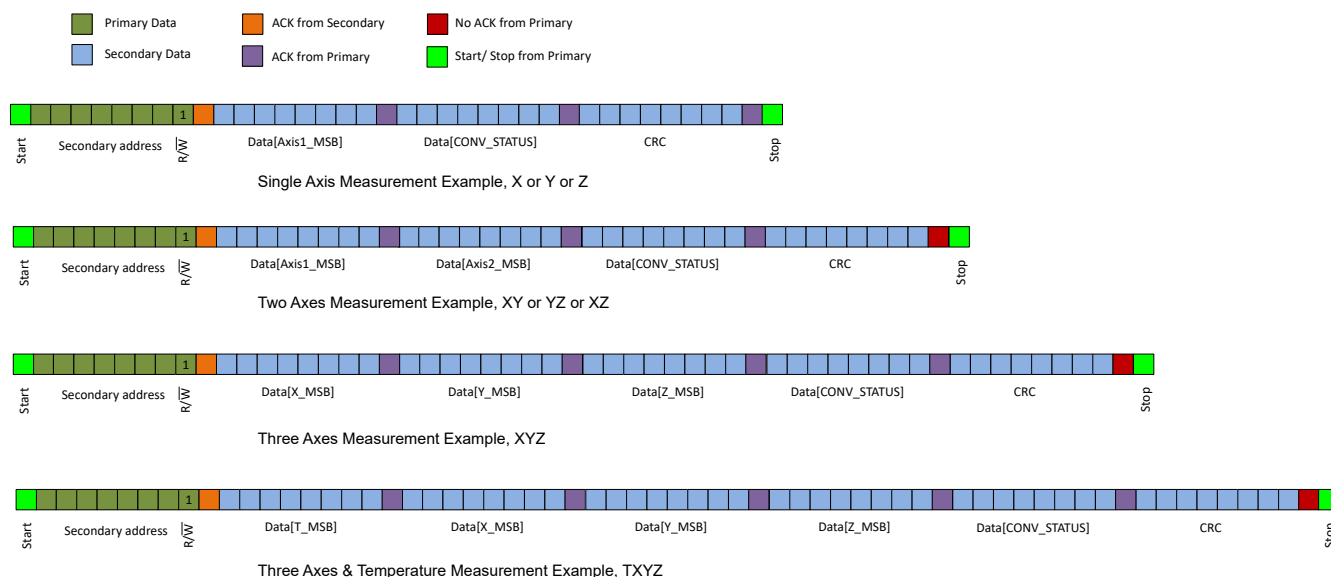
In the 1-byte read command for 16-bit data only up to 3 channels data can be sent when CRC is enabled. This restriction doesn't apply if CRC is disabled.

#### 7.5.1.3.5 1-Byte I<sup>2</sup>C Read Command for 8-Bit Data

Figure 7-13 and Figure 7-14 show examples of 1-byte I<sup>2</sup>C read command supported by the TMAG5173-Q1. Select I2C\_RD = 10b to enable this mode. The command byte contains 7-bit secondary device address and a '1' at the R/W bit. In this mode, per MAG\_CH\_EN and T\_CH\_EN bits setting, the device will send 8-bit data of the enabled channels and the CONV\_STATUS register data byte. If CRC is enabled, the device will send an additional CRC byte based off the CRC calculation of the command byte and the data sent in the current packet. When multiple channels are enabled, the sent data follows the T, X, Y, and Z sequence in the successive data bytes.



**Figure 7-13. 1-Byte I<sup>2</sup>C Read Command for 8-Bit Data With CRC Disabled, CRC\_EN = 0b**



**Figure 7-14. 1-Byte I<sup>2</sup>C Read Command for 8-Bit Data With CRC Enabled, CRC\_EN = 1b**

#### Note

In the 1-byte read command for 8-bit data any combinations of channels can be sent without restrictions.

#### 7.5.1.3.6 I<sup>2</sup>C Read CRC

The TMAG5173-Q1 supports optional CRC during I<sup>2</sup>C read. The CRC can be enabled through the CRC\_EN register bit. The CRC is performed on a data string that is determined by the I<sup>2</sup>C read type. The CRC information is sent as a single byte after the data bytes. The code is generated by the polynomial  $x^8 + x^2 + x + 1$ . Initial CRC bits are FFh.

The following equations can be employed to calculate CRC:

$$d = \text{Data Input, } c = \text{Initial CRC (FFh)} \quad (1)$$

$$\text{newcrc}[0] = d[7] \wedge d[6] \wedge d[0] \wedge c[0] \wedge c[6] \wedge c[7] \quad (2)$$

$$\text{newcrc}[1] = d[6] \wedge d[1] \wedge d[0] \wedge c[0] \wedge c[1] \wedge c[6] \quad (3)$$

$$\text{newcrc}[2] = d[6] \wedge d[2] \wedge d[1] \wedge d[0] \wedge c[0] \wedge c[1] \wedge c[2] \wedge c[6] \quad (4)$$

$$\text{newcrc}[3] = d[7] \wedge d[3] \wedge d[2] \wedge d[1] \wedge c[1] \wedge c[2] \wedge c[3] \wedge c[7] \quad (5)$$

$$\text{newcrc}[4] = d[4] \wedge d[3] \wedge d[2] \wedge c[2] \wedge c[3] \wedge c[4] \quad (6)$$

$$\text{newcrc}[5] = d[5] \wedge d[4] \wedge d[3] \wedge c[3] \wedge c[4] \wedge c[5] \quad (7)$$

$$\text{newcrc}[6] = d[6] \wedge d[5] \wedge d[4] \wedge c[4] \wedge c[5] \wedge c[6] \quad (8)$$

$$\text{newcrc}[7] = d[7] \wedge d[6] \wedge d[5] \wedge c[5] \wedge c[6] \wedge c[7] \quad (9)$$

The following examples show calculated CRC byte based off various input data:

I2C Data 00h : CRC = F3h

I2C Data FFh : CRC = 00h

I2C Data 80h : CRC = 7Ah

I2C Data 4Ch : CRC = 10h

I2C Data E0h : CRC = 5Dh

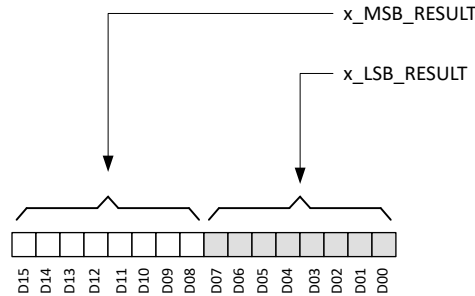
I2C Data 00000000h : CRC = D1h

I2C Data FFFFFFFFh : CRC = 0Fh

## 7.5.2 Data Definition

### 7.5.2.1 Magnetic Sensor Data

The X, Y, and Z magnetic sensor data are stored in x\_MSB\_RESULT and x\_LSB\_RESULT registers. [Figure 7-15](#) shows that each sensor output stored in a 16-bit 2's complement format in two 8-bit registers. The data can be retrieved as 16-bit format combining both MSB and LSB registers, or as 8-bit format through the MSB register.



**Figure 7-15. Magnetic Sensor Data Definition**

The measured magnetic field can be calculated using [Equation 10](#) for 16-bit data, and using [Equation 11](#) for 8-bit data.

$$B = \frac{-(D_{15} \times 2^{15}) + \sum_{i=0}^{14} D_i \times 2^i}{2^{16}} \times 2|B_R| \quad (10)$$

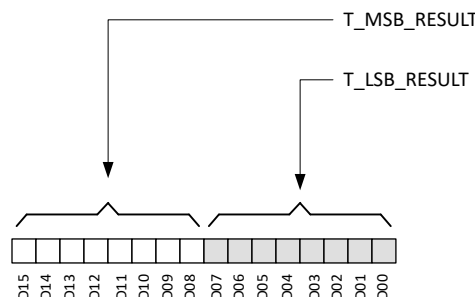
where

- B is magnetic field in mT.
- $D_i$  is the data bit shown in [Figure 7-15](#).
- $B_R$  is the magnetic range in mT for the corresponding channel.

$$B = \frac{-(D_{15} \times 2^7) + \sum_{i=0}^6 D_i \times 2^i}{2^8} \times 2|B_R| \quad (11)$$

### 7.5.2.2 Temperature Sensor Data

The TMAG5173-Q1 will measure temperature from  $-40^{\circ}\text{C}$  to  $170^{\circ}\text{C}$ . The temperature sensor data are stored in T\_MSB\_RESULT and T\_LSB\_RESULT registers. [Figure 7-16](#) shows the sensor output stored in a 16-bit 2's complement format in two 8-bit registers. The data can be retrieved as 16-bit format combining both MSB and LSB registers, or as 8-bit format through the MSB register.



**Figure 7-16. Temperature Sensor Data Definition**

Use Equation 12 to calculate the measured temperature in degree Celsius for 16-bit data, and use Equation 13 to calculate the measured temperature for 8-bit data.

$$T = T_{SENS\_T0} + \frac{T_{ADC\_T} - T_{ADC\_T0}}{T_{ADC\_RES}} \quad (12)$$

$$T = T_{SENS\_T0} + \frac{256 \times \left( T_{ADC\_T} - \frac{T_{ADC\_T0}}{256} \right)}{T_{ADC\_RES}} \quad (13)$$

where

- T is the measured temperature in degree Celsius.
- T<sub>SENS\_T0</sub> as listed in the *Electrical Characteristics* table.
- T<sub>ADC\_RES</sub> is the change in ADC code per degree Celsius.
- T<sub>ADC\_T0</sub> as listed in the *Electrical Characteristics* table.
- T<sub>ADC\_T</sub> is the measured ADC code for temperature T.

### 7.5.2.3 Angle and Magnitude Data Definition

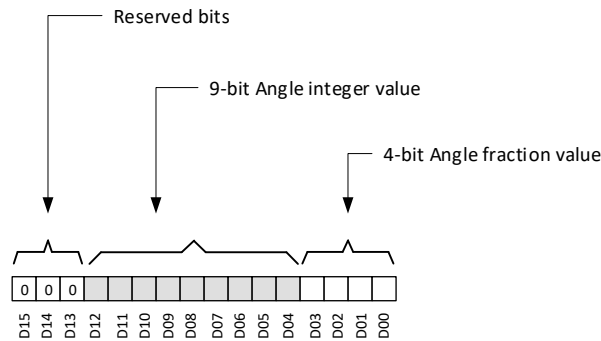
The TMAG5173-Q1 calculates the angle from a pair of magnetic axes based off the ANGLE\_EN register bits setting. Figure 7-17 shows the angle information stored in the ANGLE\_RESULT\_MSB and ANGLE\_RESULT\_LSB registers. Bits D04-D12 store angle integer value from 0 to 360 degree. Bits D00-D03 store fractional angle value. The 3-MSB bits are always populated as b000. Use Equation 14 to calculate the angle value.

$$A = \sum_{i=4}^{12} D_i \times 2^{i-4} + \frac{\sum_{i=0}^3 D_i \times 2^i}{16} \quad (14)$$

where

- A is the angle measured in degree.
- D<sub>i</sub> is the data bit as shown in Figure 7-17.

For example: a 354.50 degree is populated as 0001 0110 0010 1000b and a 17.25 degree is populated as 000 0001 0001 0100b.



**Figure 7-17. Angle Data Definition**

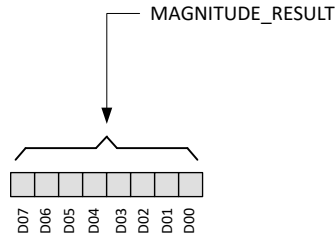
During the angle calculation, use Equation 15 to calculate the resultant vector magnitude.

$$M = \sqrt{MADC_{Ch1}^2 + MADC_{Ch2}^2} \quad (15)$$

where

- MADC<sub>Ch1</sub>, MADC<sub>Ch2</sub> are the ADC codes of the two magnetic channels selected for the angle calculation.

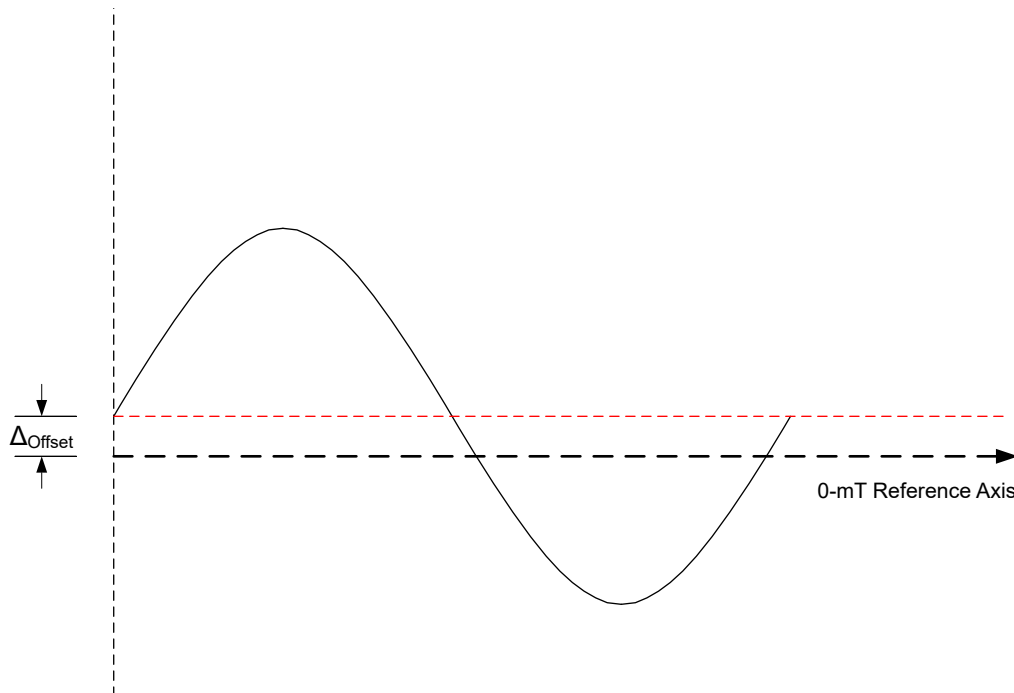
Figure 7-18 shows the magnitude value stored in the MAGNITUDE\_RESULT register. For on-axis angular measurement the magnitude value should remain constant across the full 360° measurement.



**Figure 7-18. Magnitude Result Data Definition**

#### 7.5.2.4 Magnetic Sensor Offset Correction

The TMAG5173-Q1 enables offset correction for a pair of magnetic axes (see [Figure 7-19](#)). The MAG\_OFFSET\_CONFIG\_1 and MAG\_OFFSET\_CONFIG\_2 registers store the offset values to be corrected in 2's complement data format. As an example, if the uncorrected waveform for a particular axis has a value that is +2 mT too high, the offset correction value of –2 mT should be entered in the corresponding offset correction register. The selection and order of the sensors are defined in the ANGLE\_EN register bits setting. The default value of these offset correction registers are set as zero.



**Figure 7-19. Magnetic Sensor Data Offset Correction**

Use [Equation 16](#) to calculate the amount of offset for each axis. As an example, with a ±40 mT range, MAG\_OFFSET\_CONFIG\_1 set at 1000 0000b, and MAG\_OFFSET\_CONFIG\_2 set at 0001 0000b, the offset correction for the first axis is –2.5 mT and second axis is 0.312 mT.

$$\Delta_{Offset} = \frac{-(D_7 \times 2^7) + \sum_{i=0}^6 D_i \times 2^i}{2^{12}} \times 2|B_R| \quad (16)$$

where

- $\Delta_{Offset}$  is the amount of offset correction to be applied in mT.
- $D_i$  is the data bit in the MAG\_OFFSET\_CONFIG\_1 or MAG\_OFFSET\_CONFIG\_2 register.
- $B_R$  is the magnetic range in mT for the corresponding channel.

Alternately, you can use [Equation 17](#) to calculate the values for MAG\_OFFSET\_CONFIG\_1 or MAG\_OFFSET\_CONFIG\_2 for a target offset correction.

$$\text{MAG\_OFFSET} = \frac{2^{12} \times \Delta_{\text{Offset}}}{2|B_R|} \quad (17)$$

where

- MAG\_OFFSET is the decimal value to be entered in the MAG\_OFFSET\_CONFIG\_1 or MAG\_OFFSET\_CONFIG\_2 register.
- $\Delta_{\text{Offset}}$  is the amount of offset correction to be applied in mT.
- $B_R$  is the magnetic range in mT for the corresponding channel.

## 7.6 TMA5173-Q1 Registers

**Table 7-6** lists the memory-mapped registers for the TMA5173-Q1 registers. All register offset addresses not listed in **Table 7-6** should be considered as reserved locations and the register contents should not be modified.

**Table 7-6. TMA5173-Q1 Registers**

| Offset | Acronym             | Register Name                    | Section                        |
|--------|---------------------|----------------------------------|--------------------------------|
| 0h     | DEVICE_CONFIG_1     | Configure Device Operation Modes | <a href="#">Section 7.6.1</a>  |
| 1h     | DEVICE_CONFIG_2     | Configure Device Operation Modes | <a href="#">Section 7.6.2</a>  |
| 2h     | SENSOR_CONFIG_1     | Sensor Device Operation Modes    | <a href="#">Section 7.6.3</a>  |
| 3h     | SENSOR_CONFIG_2     | Sensor Device Operation Modes    | <a href="#">Section 7.6.4</a>  |
| 4h     | X_THR_CONFIG        | X Threshold Configuration        | <a href="#">Section 7.6.5</a>  |
| 5h     | Y_THR_CONFIG        | Y Threshold Configuration        | <a href="#">Section 7.6.6</a>  |
| 6h     | Z_THR_CONFIG        | Z Threshold Configuration        | <a href="#">Section 7.6.7</a>  |
| 7h     | T_CONFIG            | Temp Sensor Configuration        | <a href="#">Section 7.6.8</a>  |
| 8h     | INT_CONFIG_1        | Configure Device Operation Modes | <a href="#">Section 7.6.9</a>  |
| 9h     | MAG_GAIN_CONFIG     | Configure Device Operation Modes | <a href="#">Section 7.6.10</a> |
| Ah     | MAG_OFFSET_CONFIG_1 | Configure Device Operation Modes | <a href="#">Section 7.6.11</a> |
| Bh     | MAG_OFFSET_CONFIG_2 | Configure Device Operation Modes | <a href="#">Section 7.6.12</a> |
| Ch     | I2C_ADDRESS         | I2C Address Register             | <a href="#">Section 7.6.13</a> |
| Dh     | DEVICE_ID           | ID for the device die            | <a href="#">Section 7.6.14</a> |
| Eh     | MANUFACTURER_ID_LSB | Manufacturer ID lower byte       | <a href="#">Section 7.6.15</a> |
| Fh     | MANUFACTURER_ID_MSB | Manufacturer ID upper byte       | <a href="#">Section 7.6.16</a> |
| 10h    | T_MSB_RESULT        | Conversion Result Register       | <a href="#">Section 7.6.17</a> |
| 11h    | T_LSB_RESULT        | Conversion Result Register       | <a href="#">Section 7.6.18</a> |
| 12h    | X_MSB_RESULT        | Conversion Result Register       | <a href="#">Section 7.6.19</a> |
| 13h    | X_LSB_RESULT        | Conversion Result Register       | <a href="#">Section 7.6.20</a> |
| 14h    | Y_MSB_RESULT        | Conversion Result Register       | <a href="#">Section 7.6.21</a> |
| 15h    | Y_LSB_RESULT        | Conversion Result Register       | <a href="#">Section 7.6.22</a> |
| 16h    | Z_MSB_RESULT        | Conversion Result Register       | <a href="#">Section 7.6.23</a> |
| 17h    | Z_LSB_RESULT        | Conversion Result Register       | <a href="#">Section 7.6.24</a> |
| 18h    | CONV_STATUS         | Conversion Status Register       | <a href="#">Section 7.6.25</a> |
| 19h    | ANGLE_RESULT_MSB    | Conversion Result Register       | <a href="#">Section 7.6.26</a> |
| 1Ah    | ANGLE_RESULT_LSB    | Conversion Result Register       | <a href="#">Section 7.6.27</a> |
| 1Bh    | MAGNITUDE_RESULT    | Conversion Result Register       | <a href="#">Section 7.6.28</a> |
| 1Ch    | DEVICE_STATUS       | Device_Diag Status Register      | <a href="#">Section 7.6.29</a> |

Complex bit access types are encoded to fit into small table cells. **Table 7-7** shows the codes that are used for access types in this section.

**Table 7-7. TMA5173-Q1 Access Type Codes**

| Access Type            | Code         | Description                                       |
|------------------------|--------------|---------------------------------------------------|
| Read Type              |              |                                                   |
| R                      | R            | Read                                              |
| Write Type             |              |                                                   |
| W                      | W            | Write                                             |
| W1CP                   | W<br>1C<br>P | Write<br>1 to clear<br>Requires privileged access |
| Reset or Default Value |              |                                                   |

**Table 7-7. TMAG5173-Q1 Access Type Codes  
(continued)**

| Access Type | Code | Description                            |
|-------------|------|----------------------------------------|
| -n          |      | Value after reset or the default value |

### 7.6.1 DEVICE\_CONFIG\_1 Register (Offset = 0h) [Reset = 00h]

DEVICE\_CONFIG\_1 is shown in [Table 7-8](#).

Return to the [Summary Table](#).

**Table 7-8. DEVICE\_CONFIG\_1 Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|-----|------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | CRC_EN     | R/W  | 0h    | Enables I2C CRC byte to be sent.<br>0h = CRC disabled<br>1h = CRC enabled                                                                                                                                                                                                                                                                                                                                                                                                   |
| 6-5 | MAG_TEMPCO | R/W  | 0h    | Temperature coefficient of the magnet.<br>0h = 0 %/°C (No temperature compensation)<br>1h = 0.12 %/°C (NdFe)<br>2h = 0.03 %/°C (SmCo)<br>3h = 0.20 %/°C (Ceramic)                                                                                                                                                                                                                                                                                                           |
| 4-2 | CONV_AVG   | R/W  | 0h    | Enables additional sampling of the sensor data to reduce the noise effect (or to increase resolution).<br>0h = 1x average, 10.0-kSPS (3-axes) or 20-kSPS (1 axis)<br>1h = 2x average, 5.7-kSPS (3-axes) or 13.3-kSPS (1 axis)<br>2h = 4x average, 3.1-kSPS (3-axes) or 8.0-kSPS (1 axis)<br>3h = 8x average, 1.6-kSPS (3-axes) or 4.4-kSPS (1 axis)<br>4h = 16x average, 0.8-kSPS (3-axes) or 2.4-kSPS (1 axis)<br>5h = 32x average, 0.4-kSPS (3-axes) or 1.2-kSPS (1 axis) |
| 1-0 | I2C_RD     | R/W  | 0h    | Defines the I2C read mode.<br>0h = Standard I2C 3-byte read command<br>1h = 1-byte I2C read command for 16bit sensor data and conversion status<br>2h = 1-byte I2C read command for 8 bit sensor MSB data and conversion status<br>3h = Reserved                                                                                                                                                                                                                            |

### 7.6.2 DEVICE\_CONFIG\_2 Register (Offset = 1h) [Reset = 00h]

DEVICE\_CONFIG\_2 is shown in [Table 7-9](#).

Return to the [Summary Table](#).

**Table 7-9. DEVICE\_CONFIG\_2 Register Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-----|----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-5 | THR_HYST | R/W  | 0h    | Select threshold band for the interrupt function, or hysteresis for the switch function. As an example, with 40-mT range the threshold band or hysteresis value, when THR_HYST set at 2h, $((40/(2^{11})) * 8 = 0.156$ mT.<br>0h = Takes the 2's complement value of each x_THR_CONFIG register to create a magnetic threshold of the corresponding axis<br>1h = Takes the 7 LSB bits of the x_THR_CONFIG register to create two opposite magnetic thresholds (one north, and another south) of equal magnitude.<br>2h = 8 LSB threshold band, 12 bit resolution<br>3h = 16 LSB threshold band, 12 bit resolution<br>4h = 32 LSB threshold band, 12 bit resolution<br>5h = 64 LSB threshold band, 12 bit resolution<br>6h = 128 LSB threshold band, 12 bit resolution<br>7h = 256 LSB threshold band, 12 bit resolution |

**Table 7-9. DEVICE\_CONFIG\_2 Register Field Descriptions (continued)**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                |
|-----|-------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4   | LP_LN             | R/W  | 0h    | Selects the modes between low active current or low-noise modes.<br>0h = Low active current mode<br>1h = Low noise mode                                                                                                                                                                                                                                                                                    |
| 3   | I2C_GLITCH_FILTER | R/W  | 0h    | I2C glitch filter.<br>0h = Glitch filter on<br>1h = Glitch filter off                                                                                                                                                                                                                                                                                                                                      |
| 2   | TRIGGER_MODE      | R/W  | 0h    | Selects a condition which initiates a single conversion based off already configured registers. A running conversion completes before executing a trigger. Redundant triggers are ignored. TRIGGER_MODE is available only during the mode explicitly mentioned in OPERATING_MODE.<br>0h = Conversion starts at I2C command bits, default<br>1h = Conversion starts through a trigger signal at the INT pin |
| 1-0 | OPERATING_MODE    | R/W  | 0h    | Selects the device operating mode.<br>0h = Standby mode (starts new conversion at trigger event)<br>1h = Sleep mode<br>2h = Continuous measure mode<br>3h = Reserved                                                                                                                                                                                                                                       |

### 7.6.3 SENSOR\_CONFIG\_1 Register (Offset = 2h) [Reset = 00h]

SENSOR\_CONFIG\_1 is shown in [Table 7-10](#).

Return to the [Summary Table](#).

**Table 7-10. SENSOR\_CONFIG\_1 Register Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|-----|-----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-4 | MAG_CH_EN | R/W  | 0h    | Enables data acquisition of the magnetic channel(s).<br>0h = All magnetic channels of off, default<br>1h = X channel enabled<br>2h = Y channel enabled<br>3h = X, Y channel enabled<br>4h = Z channel enabled<br>5h = Z, X channel enabled<br>6h = Y, Z channel enabled<br>7h = X, Y, Z channel enabled<br>8h = YX channel enabled<br>9h = YXY channel enabled<br>Ah = YZY channel enabled<br>Bh = XZX channel enabled<br>Ch = X, Y, Z with positive AFE diagnostic check<br>Dh = X, Y, Z with negative AFE diagnostic check<br>Eh = Hall resistance check + ADC check<br>Fh = Hall offset check +ADC check |
| 3-0 | RESERVED  | R    | 0h    | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |

### 7.6.4 SENSOR\_CONFIG\_2 Register (Offset = 3h) [Reset = 00h]

SENSOR\_CONFIG\_2 is shown in [Table 7-11](#).

Return to the [Summary Table](#).

**Table 7-11. SENSOR\_CONFIG\_2 Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                               |
|-----|------------|------|-------|---------------------------------------------------------------------------------------------------------------------------|
| 7   | RESERVED   | R    | 0h    | Reserved                                                                                                                  |
| 6   | THRX_COUNT | R/W  | 0h    | Number of threshold crossings before the interrupt is asserted.<br>0h = 1 threshold crossing<br>1h = 4 threshold crossing |

**Table 7-11. SENSOR\_CONFIG\_2 Register Field Descriptions (continued)**

| Bit | Field       | Type | Reset | Description                                                                                                                                                                                                                                         |
|-----|-------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 5   | MAG_THR_DIR | R/W  | 0h    | Selects the direction of threshold check. This bit is ignored when THR_HYST > 001b.<br>0h = sets interrupt for field above the threshold<br>1h = sets interrupt for field below the threshold                                                       |
| 4   | MAG_GAIN_CH | R/W  | 0h    | Selects the axis for magnitude gain correction value entered in MAG_GAIN_CONFIG register.<br>0h = 1st channel is selected for gain adjustment<br>1h = 2nd channel is selected for gain adjustment                                                   |
| 3-2 | ANGLE_EN    | R/W  | 0h    | Enables angle calculation, magnetic gain, and offset corrections between two selected magnetic channels.<br>0h = No angle calculation, magnitude gain, and offset correction enabled<br>1h = X 1st, Y 2nd<br>2h = Y 1st, Z 2nd<br>3h = X 1st, Z 2nd |
| 1   | X_Y_RANGE   | R/W  | 0h    | Select the X and Y axes magnetic range from 2 different options.<br>0h = ±40mT (TMAG5173A1) or ±133mT (TMAG5173A2), default<br>1h = ±80mT (TMAG5173A1) or ±266mT (TMAG5173A2)                                                                       |
| 0   | Z_RANGE     | R/W  | 0h    | Select the Z axis magnetic range from 2 different options.<br>0h = ±40mT (TMAG5173A1) or ±133mT (TMAG5173A2), default<br>1h = ±80mT (TMAG5173A1) or ±266mT (TMAG5173A2)                                                                             |

**7.6.5 X\_THR\_CONFIG Register (Offset = 4h) [Reset = 00h]**

X\_THR\_CONFIG is shown in [Table 7-12](#).

Return to the [Summary Table](#).

**Table 7-12. X\_THR\_CONFIG Register Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                                                                                                                                                                                                                |
|-----|--------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | X_THR_CONFIG | R/W  | 0h    | 8-bit, 2's complement X axis threshold code for limit check. The range of possible threshold entries can be from -128 to 127. The threshold value in mT is calculated for A1 as $(40(1+X\_Y\_RANGE)/128)*X\_THR\_CONFIG$ , for A2 as $(133(1+X\_Y\_RANGE)/128)*X\_THR\_CONFIG$ . Default 0h means no threshold comparison. |

**7.6.6 Y\_THR\_CONFIG Register (Offset = 5h) [Reset = 00h]**

Y\_THR\_CONFIG is shown in [Table 7-13](#).

Return to the [Summary Table](#).

**Table 7-13. Y\_THR\_CONFIG Register Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                                                                                                                                                                                                                |
|-----|--------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | Y_THR_CONFIG | R/W  | 0h    | 8-bit, 2's complement Y axis threshold code for limit check. The range of possible threshold entries can be from -128 to 127. The threshold value in mT is calculated for A1 as $(40(1+X\_Y\_RANGE)/128)*Y\_THR\_CONFIG$ , for A2 as $(133(1+X\_Y\_RANGE)/128)*Y\_THR\_CONFIG$ . Default 0h means no threshold comparison. |

### 7.6.7 Z\_THR\_CONFIG Register (Offset = 6h) [Reset = 00h]

Z\_THR\_CONFIG is shown in [Table 7-14](#).

Return to the [Summary Table](#).

**Table 7-14. Z\_THR\_CONFIG Register Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                                                                                                                                                                                                          |
|-----|--------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | Z_THR_CONFIG | R/W  | 0h    | 8-bit, 2's complement Z axis threshold code for limit check. The range of possible threshold entries can be from -128 to 127. The threshold value in mT is calculated for A1 as $(40(1+Z\_RANGE)/128)*Z\_THR\_CONFIG$ , for A2 as $(133(1+Z\_RANGE)/128)*Z\_THR\_CONFIG$ . Default 0h means no threshold comparison. |

### 7.6.8 T\_CONFIG Register (Offset = 7h) [Reset = 00h]

T\_CONFIG is shown in [Table 7-15](#).

Return to the [Summary Table](#).

**Table 7-15. T\_CONFIG Register Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                                                                                                                           |
|-----|--------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | T_THR_CONFIG | R/W  | 0h    | Temperature threshold code entered by user. The valid temperature threshold ranges are -41C to 170C with the threshold codes for -41C = 1Ah, and 170C = 34h. Resolution is 8-degree C/ LSB. Default 0h means no threshold comparison. |
| 0   | T_CH_EN      | R/W  | 0h    | Enables data acquisition of the temperature channel.<br>0h = Temp channel disabled<br>1h = Temp channel enabled                                                                                                                       |

### 7.6.9 INT\_CONFIG\_1 Register (Offset = 8h) [Reset = 00h]

INT\_CONFIG\_1 is shown in [Table 7-16](#).

Return to the [Summary Table](#).

**Table 7-16. INT\_CONFIG\_1 Register Field Descriptions**

| Bit | Field       | Type | Reset | Description                                                                                                                                                                                                                           |
|-----|-------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | RSLT_INT    | R/W  | 0h    | Enable interrupt response when conversion result is complete.<br>0h = Interrupt is not asserted when the configured set of conversions are complete<br>1h = Interrupt is asserted when the configured set of conversions are complete |
| 6   | THRSLED_INT | R/W  | 0h    | Enable interrupt response on a predefined threshold cross.<br>0h = Interrupt is not asserted when a threshold is crossed<br>1h = Interrupt is asserted when a threshold is crossed                                                    |
| 5   | INT_STATE   | R/W  | 0h    | INT interrupt latched or pulsed.<br>0h = INT interrupt latched until clear by a primary addressing the device<br>1h = INT interrupt pulse for 10 us                                                                                   |

**Table 7-16. INT\_CONFIG\_1 Register Field Descriptions (continued)**

| Bit | Field     | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|-----|-----------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4-2 | INT_MODE  | R/W  | 0h    | Interrupt mode select.<br>0h = No interrupt<br>1h = Interrupt through $\overline{\text{INT}}$<br>2h = Interrupt through $\overline{\text{INT}}$ except when I2C bus is busy.<br>3h = Interrupt through SCL<br>4h = Interrupt through SCL except when I2C bus is busy.<br>5h = Unipolar switch function during continuous measure mode (only one magnetic field conversion support, selects the first magnetic field in X, Y, Z order if multiple thresholds are enabled). This mode overrides any interrupt function (INT trigger is also disabled), and only implements a Hall switch function based off the x_THRX_CONFIG and THR_HYST settings. Select THR_HYST >001b for this mode.<br>6h = Omnipolar switch function during continuous measure mode (only one magnetic field conversion support, selects the first magnetic field in X, Y, Z order if multiple thresholds are enabled). This mode overrides any interrupt function (INT trigger is also disabled), and only implements a Hall switch function based off the x_THRX_CONFIG and THR_HYST settings. Select THR_HYST >001b for this mode.<br>7h = Not valid- defaults to 000b mode |
| 1   | RESERVED  | R    | 0h    | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 0   | MASK_INTB | R/W  | 0h    | Mask $\overline{\text{INT}}$ pin when $\overline{\text{INT}}$ connected to GND.<br>0h = $\overline{\text{INT}}$ pin is enabled<br>1h = $\overline{\text{INT}}$ pin is disabled (for wake-up and trigger functions)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |

**7.6.10 MAG\_GAIN\_CONFIG Register (Offset = 9h) [Reset = 00h]**

MAG\_GAIN\_CONFIG is shown in [Table 7-17](#).

Return to the [Summary Table](#).

**Table 7-17. MAG\_GAIN\_CONFIG Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                          |
|-----|------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | GAIN_VALUE | R/W  | 0h    | 8-bit gain value determined by a primary to adjust a Hall axis gain. The particular axis is selected based off the settings of MAG_GAIN_CH and ANGLE_EN register bits. The binary 8-bit input is interpreted as a fractional value in between 0 and 1 based off the formula, 'user entered value in decimal/256'. Gain value of 0 is interpreted by the device as 1. |

**7.6.11 MAG\_OFFSET\_CONFIG\_1 Register (Offset = Ah) [Reset = 00h]**

MAG\_OFFSET\_CONFIG\_1 is shown in [Table 7-18](#).

Return to the [Summary Table](#).

**Table 7-18. MAG\_OFFSET\_CONFIG\_1 Register Field Descriptions**

| Bit | Field            | Type | Reset | Description                                                                                                                                                                                                                                                                                                                            |
|-----|------------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | OFFSET_VALUE_1ST | R/W  | 0h    | 8-bit, 2's complement number entered by a primary to adjust the 1st axis offset during angle calculation. The 1st axis is defined in ANGLE_EN register bits. The range of possible valid entrees in decimal numbers can be -128 to 127. The offset value is calculated by multiplying bit resolution (uT/ LSB) with the entered value. |

### 7.6.12 MAG\_OFFSET\_CONFIG\_2 Register (Offset = Bh) [Reset = 00h]

MAG\_OFFSET\_CONFIG\_2 is shown in [Table 7-19](#).

Return to the [Summary Table](#).

**Table 7-19. MAG\_OFFSET\_CONFIG\_2 Register Field Descriptions**

| Bit | Field            | Type | Reset | Description                                                                                                                                                                                                                                                                                                                            |
|-----|------------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | OFFSET_VALUE_2ND | R/W  | 0h    | 8-bit, 2's complement number entered by a primary to adjust the 2nd axis offset during angle calculation. The 2nd axis is defined in ANGLE_EN register bits. The range of possible valid entrees in decimal numbers can be -128 to 127. The offset value is calculated by multiplying bit resolution (uT/ LSB) with the entered value. |

### 7.6.13 I2C\_ADDRESS Register (Offset = Ch) [Reset = 6Ah]

I2C\_ADDRESS is shown in [Table 7-20](#).

Return to the [Summary Table](#).

**Table 7-20. I2C\_ADDRESS Register Field Descriptions**

| Bit | Field                 | Type | Reset | Description                                                                                                                                                                                                                                               |
|-----|-----------------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | I2C_ADDRESS           | R/W  | 35h   | 7-bit default factory I2C address is loaded from OTP during first power up. Change these bits to a new setting if a new I2C address is required (at each power cycle these bits need to be written again to avoid going back to default factory address). |
| 0   | I2C_ADDRESS_UPDATE_EN | R/W  | 0h    | Enable a new user defined I2C address.<br>0h = Disable update of I2C address<br>1h = Enable update of I2C address with bits (7:1)                                                                                                                         |

### 7.6.14 DEVICE\_ID Register (Offset = Dh) [Reset = 04h]

DEVICE\_ID is shown in [Table 7-21](#).

Return to the [Summary Table](#).

**Table 7-21. DEVICE\_ID Register Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                          |
|-----|----------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-2 | RESERVED | R    | 1h    | Reserved                                                                                                                                                                                                             |
| 1-0 | VER      | R    | 0h    | Device version indicator. Reset value of DEVICE_ID depends on the orderable part number.<br>0h = $\pm 40$ -mT and $\pm 80$ -mT range<br>1h = Reserved<br>2h = $\pm 133$ -mT and $\pm 266$ -mT range<br>3h = Reserved |

### 7.6.15 MANUFACTURER\_ID\_LSB Register (Offset = Eh) [Reset = 49h]

MANUFACTURER\_ID\_LSB is shown in [Table 7-22](#).

Return to the [Summary Table](#).

**Table 7-22. MANUFACTURER\_ID\_LSB Register Field Descriptions**

| Bit | Field                 | Type | Reset | Description                      |
|-----|-----------------------|------|-------|----------------------------------|
| 7-0 | MANUFACTURER_ID_[7:0] | R    | 49h   | Unique manufacturer ID LSB bits. |

### 7.6.16 MANUFACTURER\_ID\_MSB Register (Offset = Fh) [Reset = 54h]

MANUFACTURER\_ID\_MSB is shown in [Table 7-23](#).

Return to the [Summary Table](#).

**Table 7-23. MANUFACTURER\_ID\_MSB Register Field Descriptions**

| Bit | Field                  | Type | Reset | Description                      |
|-----|------------------------|------|-------|----------------------------------|
| 7-0 | MANUFACTURER_ID [15:8] | R    | 54h   | Unique manufacturer ID MSB bits. |

### 7.6.17 T\_MSB\_RESULT Register (Offset = 10h) [Reset = 00h]

T\_MSB\_RESULT is shown in [Table 7-24](#).

Return to the [Summary Table](#).

**Table 7-24. T\_MSB\_RESULT Register Field Descriptions**

| Bit | Field              | Type | Reset | Description                                    |
|-----|--------------------|------|-------|------------------------------------------------|
| 7-0 | T_CH_RESULT [15:8] | R    | 0h    | T-channel data conversion results, MSB 8 bits. |

### 7.6.18 T\_LSB\_RESULT Register (Offset = 11h) [Reset = 00h]

T\_LSB\_RESULT is shown in [Table 7-25](#).

Return to the [Summary Table](#).

**Table 7-25. T\_LSB\_RESULT Register Field Descriptions**

| Bit | Field             | Type | Reset | Description                                    |
|-----|-------------------|------|-------|------------------------------------------------|
| 7-0 | T_CH_RESULT [7:0] | R    | 0h    | T-channel data conversion results, LSB 8 bits. |

### 7.6.19 X\_MSB\_RESULT Register (Offset = 12h) [Reset = 00h]

X\_MSB\_RESULT is shown in [Table 7-26](#).

Return to the [Summary Table](#).

**Table 7-26. X\_MSB\_RESULT Register Field Descriptions**

| Bit | Field              | Type | Reset | Description                                    |
|-----|--------------------|------|-------|------------------------------------------------|
| 7-0 | X_CH_RESULT [15:8] | R    | 0h    | X-channel data conversion results, MSB 8 bits. |

### 7.6.20 X\_LSB\_RESULT Register (Offset = 13h) [Reset = 00h]

X\_LSB\_RESULT is shown in [Table 7-27](#).

Return to the [Summary Table](#).

**Table 7-27. X\_LSB\_RESULT Register Field Descriptions**

| Bit | Field             | Type | Reset | Description                                    |
|-----|-------------------|------|-------|------------------------------------------------|
| 7-0 | X_CH_RESULT [7:0] | R    | 0h    | X-channel data conversion results, LSB 8 bits. |

### 7.6.21 Y\_MSB\_RESULT Register (Offset = 14h) [Reset = 00h]

Y\_MSB\_RESULT is shown in [Table 7-28](#).

Return to the [Summary Table](#).

**Table 7-28. Y\_MSB\_RESULT Register Field Descriptions**

| Bit | Field              | Type | Reset | Description                                    |
|-----|--------------------|------|-------|------------------------------------------------|
| 7-0 | Y_CH_RESULT [15:8] | R    | 0h    | Y-channel data conversion results, MSB 8 bits. |

### 7.6.22 Y\_LSB\_RESULT Register (Offset = 15h) [Reset = 00h]

Y\_LSB\_RESULT is shown in [Table 7-29](#).

Return to the [Summary Table](#).

**Table 7-29. Y\_LSB\_RESULT Register Field Descriptions**

| Bit | Field             | Type | Reset | Description                                    |
|-----|-------------------|------|-------|------------------------------------------------|
| 7-0 | Y_CH_RESULT [7:0] | R    | 0h    | Y-channel data conversion results, LSB 8 bits. |

### 7.6.23 Z\_MSB\_RESULT Register (Offset = 16h) [Reset = 00h]

Z\_MSB\_RESULT is shown in [Table 7-30](#).

Return to the [Summary Table](#).

**Table 7-30. Z\_MSB\_RESULT Register Field Descriptions**

| Bit | Field              | Type | Reset | Description                                    |
|-----|--------------------|------|-------|------------------------------------------------|
| 7-0 | Z_CH_RESULT [15:8] | R    | 0h    | Z-channel data conversion results, MSB 8 bits. |

### 7.6.24 Z\_LSB\_RESULT Register (Offset = 17h) [Reset = 00h]

Z\_LSB\_RESULT is shown in [Table 7-31](#).

Return to the [Summary Table](#).

**Table 7-31. Z\_LSB\_RESULT Register Field Descriptions**

| Bit | Field             | Type | Reset | Description                                    |
|-----|-------------------|------|-------|------------------------------------------------|
| 7-0 | Z_CH_RESULT [7:0] | R    | 0h    | Z-channel data conversion results, LSB 8 bits. |

### 7.6.25 CONV\_STATUS Register (Offset = 18h) [Reset = 10h]

CONV\_STATUS is shown in [Table 7-32](#).

Return to the [Summary Table](#).

**Table 7-32. CONV\_STATUS Register Field Descriptions**

| Bit | Field       | Type   | Reset | Description                                                                                                                                                                               |
|-----|-------------|--------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-5 | SET_COUNT   | R      | 0h    | Rolling count of conversion data sets.                                                                                                                                                    |
| 4   | POR         | R/W1CP | 1h    | Device powered up, or experienced power-on-reset. Bit is clear when host writes back '1'.<br>0h = No POR<br>1h = POR occurred                                                             |
| 3-2 | RESERVED    | R      | 0h    | Reserved                                                                                                                                                                                  |
| 1   | DIAG_STATUS | R      | 0h    | Detect any internal diagnostics fail which include VCC UV, internal memory CRC error, INT pin error and internal clock error.<br>0h = No diagnostic fail<br>1h = Diagnostic fail detected |

**Table 7-32. CONV\_STATUS Register Field Descriptions (continued)**

| Bit | Field         | Type | Reset | Description                                                                                                       |
|-----|---------------|------|-------|-------------------------------------------------------------------------------------------------------------------|
| 0   | RESULT_STATUS | R    | 0h    | Conversion data buffer is ready to be read.<br>0h = Conversion data not complete<br>1h = Conversion data complete |

### 7.6.26 ANGLE\_RESULT\_MSB Register (Offset = 19h) [Reset = 00h]

ANGLE\_RESULT\_MSB is shown in [Table 7-33](#).

Return to the [Summary Table](#).

**Table 7-33. ANGLE\_RESULT\_MSB Register Field Descriptions**

| Bit | Field            | Type | Reset | Description                                                                                                                                                                                                                  |
|-----|------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | ANGLE_RESULT_MSB | R    | 0h    | Angle measurement result in degree. The data is displayed from 0 to 360 degree in 13 LSB bits after combining the ANGLE_RESULT_MSB and _LSB bits. The 4 LSB bits allocated for fraction of an angle in the format (xxxx/16). |

### 7.6.27 ANGLE\_RESULT\_LSB Register (Offset = 1Ah) [Reset = 00h]

ANGLE\_RESULT\_LSB is shown in [Table 7-34](#).

Return to the [Summary Table](#).

**Table 7-34. ANGLE\_RESULT\_LSB Register Field Descriptions**

| Bit | Field            | Type | Reset | Description                                                                                                                                                                                                                  |
|-----|------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | ANGLE_RESULT_LSB | R    | 0h    | Angle measurement result in degree. The data is displayed from 0 to 360 degree in 13 LSB bits after combining the ANGLE_RESULT_MSB and _LSB bits. The 4 LSB bits allocated for fraction of an angle in the format (xxxx/16). |

### 7.6.28 MAGNITUDE\_RESULT Register (Offset = 1Bh) [Reset = 00h]

MAGNITUDE\_RESULT is shown in [Table 7-35](#).

Return to the [Summary Table](#).

**Table 7-35. MAGNITUDE\_RESULT Register Field Descriptions**

| Bit | Field            | Type | Reset | Description                                                                                                                                                                                                                                                                                                                            |
|-----|------------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-0 | MAGNITUDE_RESULT | R    | 0h    | Resultant vector magnitude during angle measurement. This value should be constant during 360-degree on-axis angle measurement. The magnitude in mT can be calculated as $(\text{MAGNITUDE\_RESULT} \times 256) / (\text{LSB/mT})$ where the LSB/mT is calculated in 16-bit format as specified in the magnetic characteristics table. |

### 7.6.29 DEVICE\_STATUS Register (Offset = 1Ch) [Reset = 10h]

DEVICE\_STATUS is shown in [Table 7-36](#).

Return to the [Summary Table](#).

**Table 7-36. DEVICE\_STATUS Register Field Descriptions**

| Bit | Field    | Type   | Reset | Description                                                                                                                                                                                                                                                                                 |
|-----|----------|--------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-5 | RESERVED | R      | 0h    | Reserved                                                                                                                                                                                                                                                                                    |
| 4   | INTB_RB  | R      | 1h    | Indicates the level that the device is reading back from $\overline{\text{INT}}$ pin. The reset value of DEVICE_STATUS depends on the status of the $\overline{\text{INT}}$ pin at power-up.<br>0h = $\overline{\text{INT}}$ pin driven low<br>1h = $\overline{\text{INT}}$ pin status high |
| 3   | OSC_ER   | R/W1CP | 0h    | Indicates if Oscillator error is detected. Bit is clear when host writes back '1'.<br>0h = No oscillator error detected<br>1h = Oscillator error detected                                                                                                                                   |

**Table 7-36. DEVICE\_STATUS Register Field Descriptions (continued)**

| Bit | Field      | Type   | Reset | Description                                                                                                                                                                                          |
|-----|------------|--------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2   | INT_ER     | R/W1CP | 0h    | Indicates if $\overline{\text{INT}}$ pin error is detected. Bit is clear when host writes back '1'.<br>0h = No $\overline{\text{INT}}$ error detected<br>1h = $\overline{\text{INT}}$ error detected |
| 1   | OTP_CRC_ER | R/W1CP | 0h    | Indicates if OTP CRC error is detected. Bit is clear when host writes back '1'.<br>0h = No OTP CRC error detected<br>1h = OTP CRC error detected                                                     |
| 0   | VCC_UV_ER  | R/W1CP | 0h    | Indicates if VCC undervoltage was detected. Bit is clear when host writes back '1'.<br>0h = No VCC UV detected<br>1h = VCC UV detected                                                               |

## 8 Application and Implementation

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### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

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### 8.1 Application Information

#### 8.1.1 Select the Sensitivity Option

Select the highest TMAG5173-Q1 sensitivity option that can measure the required range of magnetic flux density so that the ADC input range is maximized.

Larger-sized magnets and farther sensing distances can generally enable better positional accuracy than very small magnets at close distances, because magnetic flux density increases exponentially with the proximity to a magnet. TI created an online tool to help with simple magnet calculations under the [TMAG5173-Q1 product folder](#) on ti.com.

#### 8.1.2 Temperature Compensation for Magnets

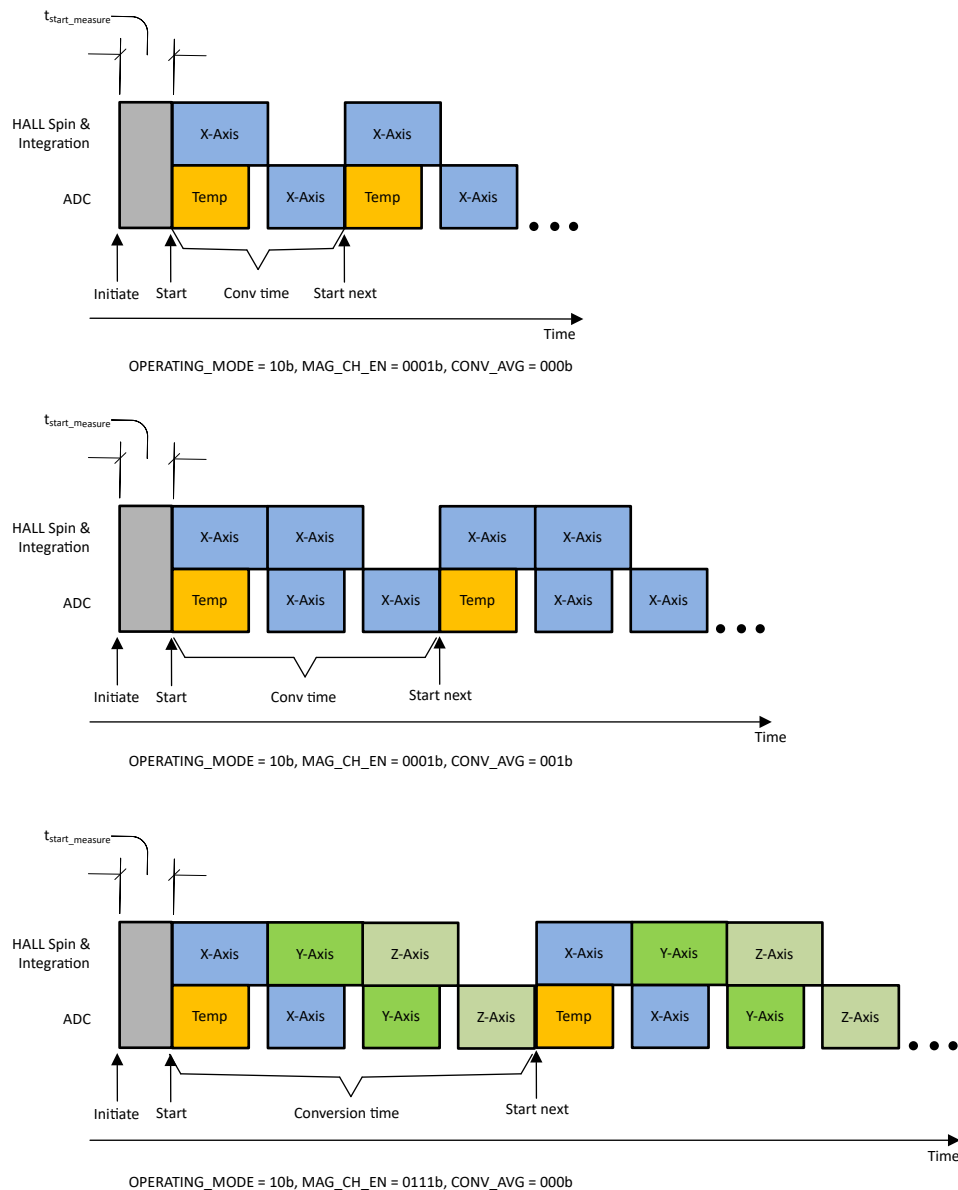
The TMAG5173-Q1 temperature compensation is designed to directly compensate the average temperature drift of several magnets as specified in the MAG\_TEMPCO register bits. The residual induction ( $B_r$ ) of a magnet typically reduces by 0.12%/°C for NdFeB, and 0.20%/°C for ferrite magnets as the temperature increases. Set the MAG\_TEMPCO bit to default 00b if the device temperature compensation is not needed.

#### 8.1.3 Sensor Conversion

Multiple conversion schemes can be adopted based off the MAG\_CH\_EN and CONV\_AVG register bits settings.

### 8.1.3.1 Continuous Conversion

The TMAG5173-Q1 can be set in continuous conversion mode when OPERATING\_MODE is set to 10b. Figure 8-1 shows a few examples of continuous conversion. The input magnetic field is processed in two steps. In the first step, the device spins the Hall sensor elements and integrates the sampled data. In the second step, the ADC block converts the analog signal into digital bits and stores in the corresponding result register. While the ADC starts processing the first magnetic sample, the spin block can start processing another magnetic sample. In this mode, the temperature data is taken at the beginning of each new conversion. This temperature data is used to compensate for the magnetic thermal drift.



**Figure 8-1. Continuous Conversion Examples**

### 8.1.3.2 Trigger Conversion

The TMAG5173-Q1 supports trigger conversion with OPERATING\_MODE set to 00b. The trigger event can be initiated through I<sup>2</sup>C command or  $\overline{\text{INT}}$  signal. Figure 8-2 shows an example of trigger conversion with temperature, X, Y, and Z sensors activated.

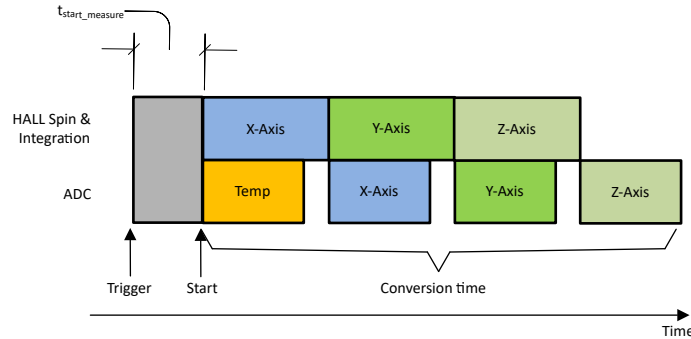


Figure 8-2. Trigger Conversion for Temperature, X, Y, & Z Sensors

### 8.1.3.3 Pseudo-Simultaneous Sampling

In absolute angle measurement, application sensor data from multiple axes are required to calculate an accurate angle. The magnetic field data collected at different times through the same signal chain introduces error in angle calculation. The TMAG5173-Q1 offers pseudo-simultaneous sampling data collection modes to eliminate this error. Figure 8-3 shows an example where MAG\_CH\_EN is set at 1011b to collect XZX data. Equation 18 shows that the time stamps for the X and Z sensor data are the same.

$$t_z = \frac{t_{x1} + t_{x2}}{2} \quad (18)$$

where

- $t_{x1}$ ,  $t_z$ ,  $t_{x2}$  are time stamps for X, Z, X sensor data completion as defined in Figure 8-3.

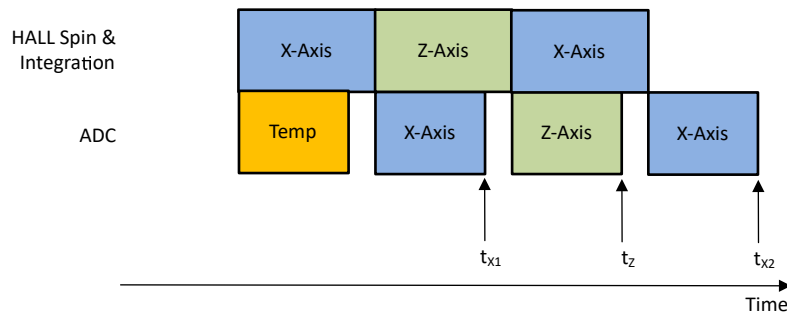
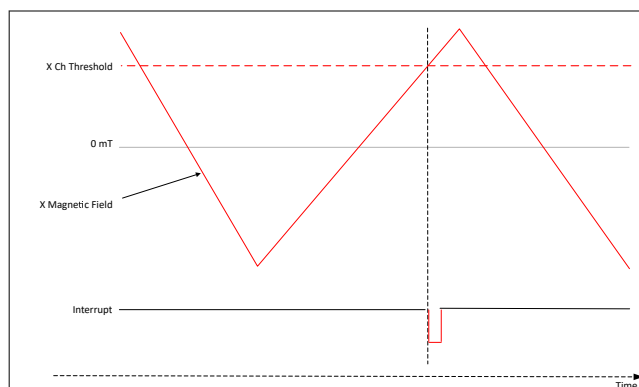


Figure 8-3. XZX Magnetic Field Conversion

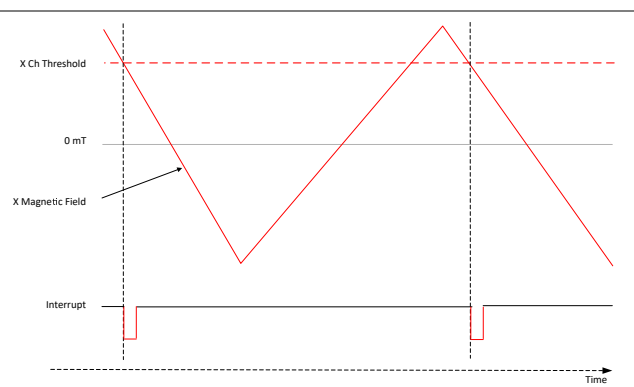
The vertical X, Y sensors of the TMAG5173-Q1 exhibit more noise than the horizontal Z sensor. The pseudo-simultaneous sampling can be used to equalize the noise floor when two set of vertical sensor data are collected against one set of horizontal sensor data, as in examples of XZX or YZY modes.

### 8.1.4 Magnetic Limit Check

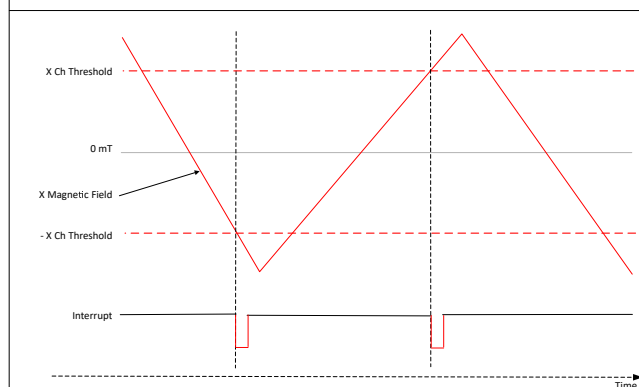
The TMAG5173-Q1 enables magnetic limit checks for single or multiple axes at the same time. Figure 8-4 to Figure 8-7 show examples of magnetic limit cross detection events while the field going above, below, exiting a magnetic band, and entering a magnetic band. The device will keep generating interrupt with each new conversion if the magnetic fields remain in the shaded regions in the figures. The MAG\_THR\_DIR and THR\_HYST register bits help select different limit cross modes.



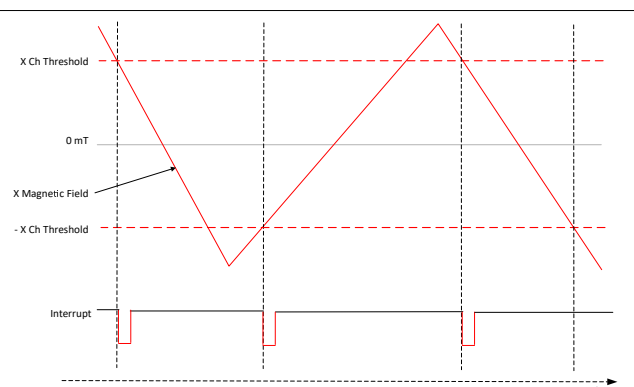
**Figure 8-4. Magnetic Upper Limit Cross Check With MAG\_THR\_DIR = 0b, THR\_HYST = 000b**



**Figure 8-5. Magnetic Lower Limit Cross Check With MAG\_THR\_DIR = 1b, THR\_HYST = 000b**



**Figure 8-6. Magnetic Field Going Out of Band Check With MAG\_THR\_DIR = 0b, THR\_HYST = 001b**



**Figure 8-7. Magnetic Field Entering a Band Check With MAG\_THR\_DIR = 1b, THR\_HYST = 001b**

### 8.1.5 Magnetic Threshold Band Cross Detection

Table 8-1 shows different threshold band width options supported by the TMAG5173-Q1. For larger threshold band use the A2 orderable. The magnetic threshold band is useful to create programmable magnetic switch and latch hysteresis.

**Table 8-1. Threshold Band Width (Upper Threshold- Lower Threshold) in mT**

| THR_HYST Codes | ±40-mT Option            | ±80-mT Option | ±133-mT Option           | ±266-mT Option |
|----------------|--------------------------|---------------|--------------------------|----------------|
|                | A1/ B1/ C1/ D1 Orderable |               | A2/ B2/ C2/ D2 Orderable |                |
| 010b           | 0.156                    | 0.312         | 0.52                     | 1.04           |
| 011b           | 0.312                    | 0.625         | 1.04                     | 2.08           |
| 100b           | 0.625                    | 1.25          | 2.08                     | 4.15           |
| 101b           | 1.25                     | 2.5           | 4.16                     | 8.30           |
| 110b           | 2.5                      | 5.0           | 8.30                     | 16.63          |
| 111b           | 5.0                      | 10.0          | 16.63                    | 33.25          |

### 8.1.6 Error Calculation During Linear Measurement

The TMAG5173-Q1 offers independent configurations to perform linear position measurements in X, Y, and Z axes. To calculate the expected error during linear measurement, the contributions from each of the individual error sources must be understood. The relevant error sources include sensitivity error, offset, noise, cross axis sensitivity, hysteresis, nonlinearity, drift across temperature, drift across life time, and so forth. For a 3-axis Hall equation like the TMAG5173-Q1, the cross-axis sensitivity and hysteresis error sources are insignificant. Use Equation 19 to estimate the linear measurement error calculation at room temperature.

$$Error_{LM\_25C} = \frac{\sqrt{(B \times SENS_{ER})^2 + B_{off}^2 + N_{RMS\_25}^2}}{B} \times 100\% \quad (19)$$

where

- Error<sub>LM\_25C</sub> is total error in % during linear measurement at 25°C.
- B is input magnetic field.
- SENS<sub>ER</sub> is sensitivity error in decimal number at 25°C. As an example, enter 0.05 for sensitivity error of 5%.
- B<sub>off</sub> is offset error at 25°C.
- N<sub>RMS\_25</sub> is RMS noise at 25°C.

In many applications, system level calibration at room temperature can nullify the offset and sensitivity errors at 25°C. The noise errors can be reduced by internally averaging by up to 32x on the device in addition to the averaging that could be done in the microcontroller. Use [Equation 20](#) to estimate the linear measurement error across temperature after calibration at room temperature.

$$Error_{LM\_Temp} = \frac{\sqrt{(B \times SENS_{DR})^2 + B_{off\_DR}^2 + N_{RMS\_Temp}^2}}{B} \times 100\% \quad (20)$$

where

- Error<sub>LM\_Temp</sub> is total error in % during linear measurement across temperature after room temperature calibration.
- B is input magnetic field.
- SENS<sub>DR</sub> is sensitivity drift in decimal number from value at 25°C. As an example, enter 0.05 for sensitivity drift of 5%.
- B<sub>off\_DR</sub> is offset drift from value at 25°C.
- N<sub>RMS\_Temp</sub> is RMS noise across temperature.

If room temperature calibration is not performed, sensitivity and offset errors at room temperature must also account for total error calculation across temperature (see [Equation 21](#)).

$$Error_{LM\_Temp\_NCal} = \frac{\sqrt{(B \times SENS_{ER})^2 + (B \times SENS_{DR})^2 + B_{off}^2 + B_{off\_DR}^2 + N_{RMS\_Temp}^2}}{B} \times 100\% \quad (21)$$

where

- Error<sub>LM\_Temp\_NCal</sub> is total error in % during linear measurement across temperature without room temperature calibration.

#### Note

In this section, error sources such as system mechanical vibration, magnet temperature gradient, earth magnetic field, nonlinearity, lifetime drift, and so forth, are not considered. The user must take these additional error sources into account while calculating overall system error budgets.

### 8.1.7 Error Calculation During Angular Measurement

The TMAG5173-Q1 offers on-chip CORDIC to measure angle data from any of the two magnetic axes. The linear magnetic axis data can be used to calculate the angle using an external CORDIC as well. To calculate the expected error during angular measurement, the contributions from each individual error source must be understood. The relevant error sources include sensitivity error, offset, noise, axis-axis mismatch, nonlinearity, drift across temperature, drift across life time, and so forth. Use the [Angle Error Calculation Tool](#) to estimate the total error during angular measurement.

### 8.2 Typical Applications

Magnetic 3D sensors are very popular due to contactless and reliable measurements, especially in applications requiring long-term measurements in rugged environments. The TMAG5173-Q1 offers design flexibility in wide

range of industrial and personal electronics applications. In this section three common application examples are discussed in details.

### 8.2.1 Angle Measurement

Magnetic angle sensors are very popular due to contactless and reliable measurements, especially in applications requiring long-term measurements in rugged environments. The TMAG5173-Q1 offers an on-chip angle calculator providing angular measurement based off any two of the magnetic axes. The two axes of interest can be selected in the ANGLE\_EN register bits. The device offers angle output in complete 360 degree scale. Take several error sources into account for angle calculation, including sensitivity error, offset error, linearity error, noise, mechanical vibration, temperature drift, and so forth.

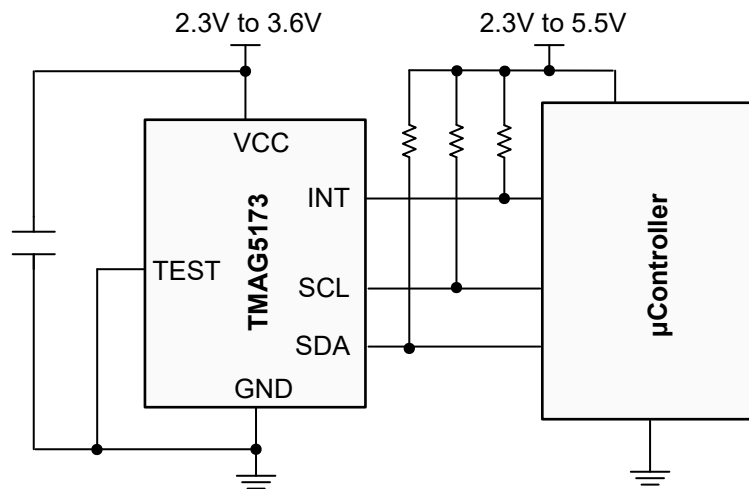


Figure 8-8. TMAG5173-Q1 Application Diagram for Angle Measurement

#### 8.2.1.1 Design Requirements

Use the parameters listed in [Table 8-2](#) for this design example.

Table 8-2. Design Parameters

| DESIGN PARAMETERS        | ON-AXIS MEASUREMENT                                                                                  | OFF-AXIS MEASUREMENT                                                                                 |
|--------------------------|------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|
| Device                   | TMAG5173A1-Q1                                                                                        | TMAG5173A1-Q1                                                                                        |
| VCC                      | 3.3 V                                                                                                | 3.3 V                                                                                                |
| Device Position          | Directly under the magnet                                                                            | At the adjacent side of the magnet                                                                   |
| Magnet                   | Cylinder: 4.7625-mm diameter, 12.7-mm thick, neodymium N52, Br = 1480                                | Cylinder: 4.7625-mm diameter, 12.7-mm thick, neodymium N52, Br = 1480                                |
| Magnetic Range Selection | Select the same range for both axes based off the highest possible magnetic field seen by the sensor | Select the same range for both axes based off the highest possible magnetic field seen by the sensor |
| RPM                      | <600                                                                                                 | <600                                                                                                 |
| Desired Accuracy         | <2° for 360° rotation                                                                                | <2° for 360° rotation                                                                                |

#### 8.2.1.2 Detailed Design Procedure

For accurate angle measurement, the two axes amplitudes must be normalized by selecting the proper gain adjustment value in the MAG\_GAIN\_CONFIG register. The gain adjustment value is a fractional decimal number between 0 and 1. The following steps must be followed to calculate this fractional value:

- Set the device at 32x average mode and rotate the shaft full 360 degree.
- Record the two axes sensor ADC codes for the full 360 degree rotation.
- A normalized plot for the full 360 degree rotations are represented in [Figure 8-10](#) or [Figure 8-11](#).
- Measure the maximum peak-peak ADC code delta for each axis,  $A_x$  and  $A_y$ .

- If  $A_X > A_Y$ , set the MAG\_GAIN\_CH register bit to 0b. Calculate the gain adjustment value for X axis:  $G_X = \frac{A_Y}{A_X}$
- If  $A_X < A_Y$ , set the MAG\_GAIN\_CH register bit to 1b. Calculate the gain adjustment value for Y axis:  $G_Y = \frac{1}{G_X}$
- The target binary gain setting at the GAIN\_VALUE register bits are calculated from the equation,  $G_X$  or  $G_Y = \text{GAIN\_VALUE}_{\text{decimal}} / 256$ .

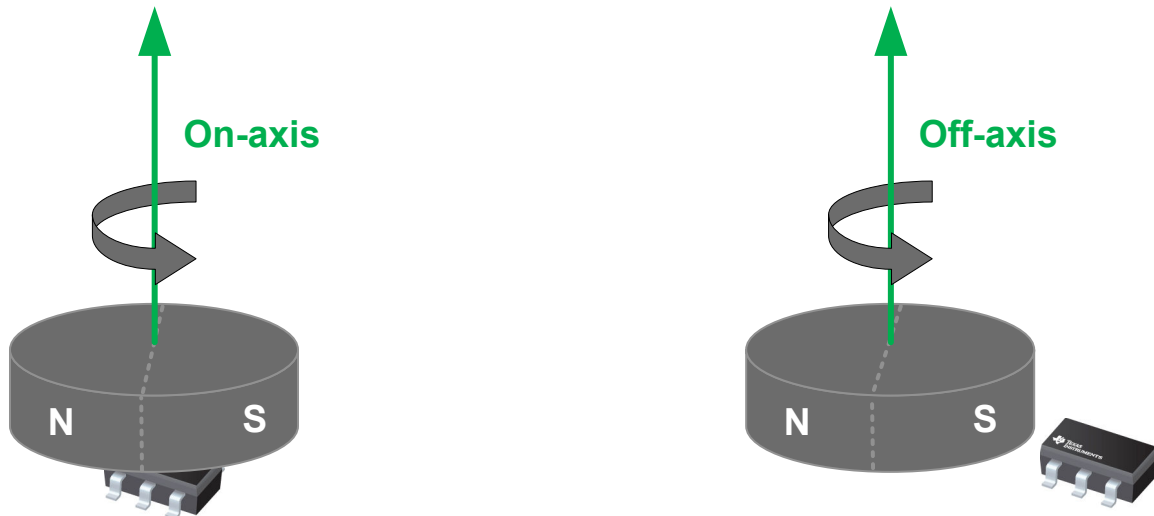
**Example 1:** If  $A_X = A_Y = 60,000$ , the GAIN\_VALUE register bits are set at default 0000 0000b.

**Example 2:** If  $A_X = 60,000$ ,  $A_Y = 45,000$ , the  $G_X = 45,000/60,000 = 0.75$ . Set MAG\_GAIN\_CH to 0b and GAIN\_VALUE to 1100 0000b.

**Example 3:** If  $A_X = 45,000$ ,  $A_Y = 60,000$ , the  $G_X = (60,000/45,000) = 1.33$ . Since  $G_X > 1$ , the gain adjustment needs to be applied to Y axis with  $G_Y = 1/G_X$ . Set MAG\_GAIN\_CH to 1b and GAIN\_VALUE to 1100 0000b.

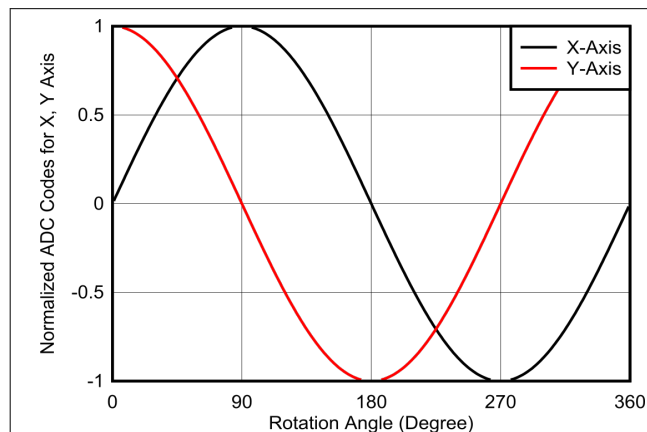
#### 8.2.1.2.1 Gain Adjustment for Angle Measurement

Common measurement topology include angular position measurements in on-axis or off-axis angular measurements shown in Figure 8-9. Select the on-axis measurement topology whenever possible as this offers the best optimization of magnetic field and the device measurement ranges. The TMAG5173-Q1 offers on-chip gain adjustment option to account for mechanical position misalignments.

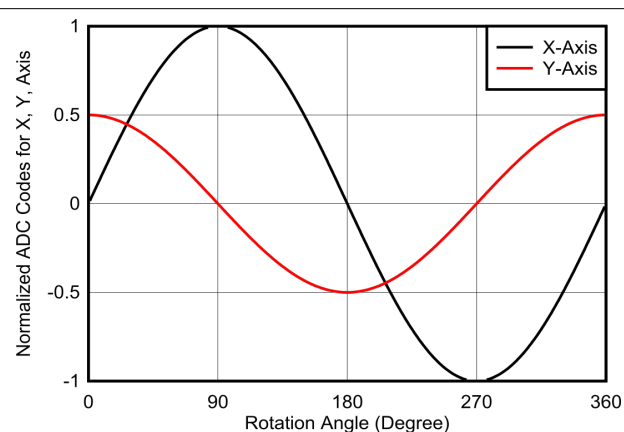


**Figure 8-9. On-Axis vs Off-Axis Angle Measurements**

### 8.2.1.3 Application Curves



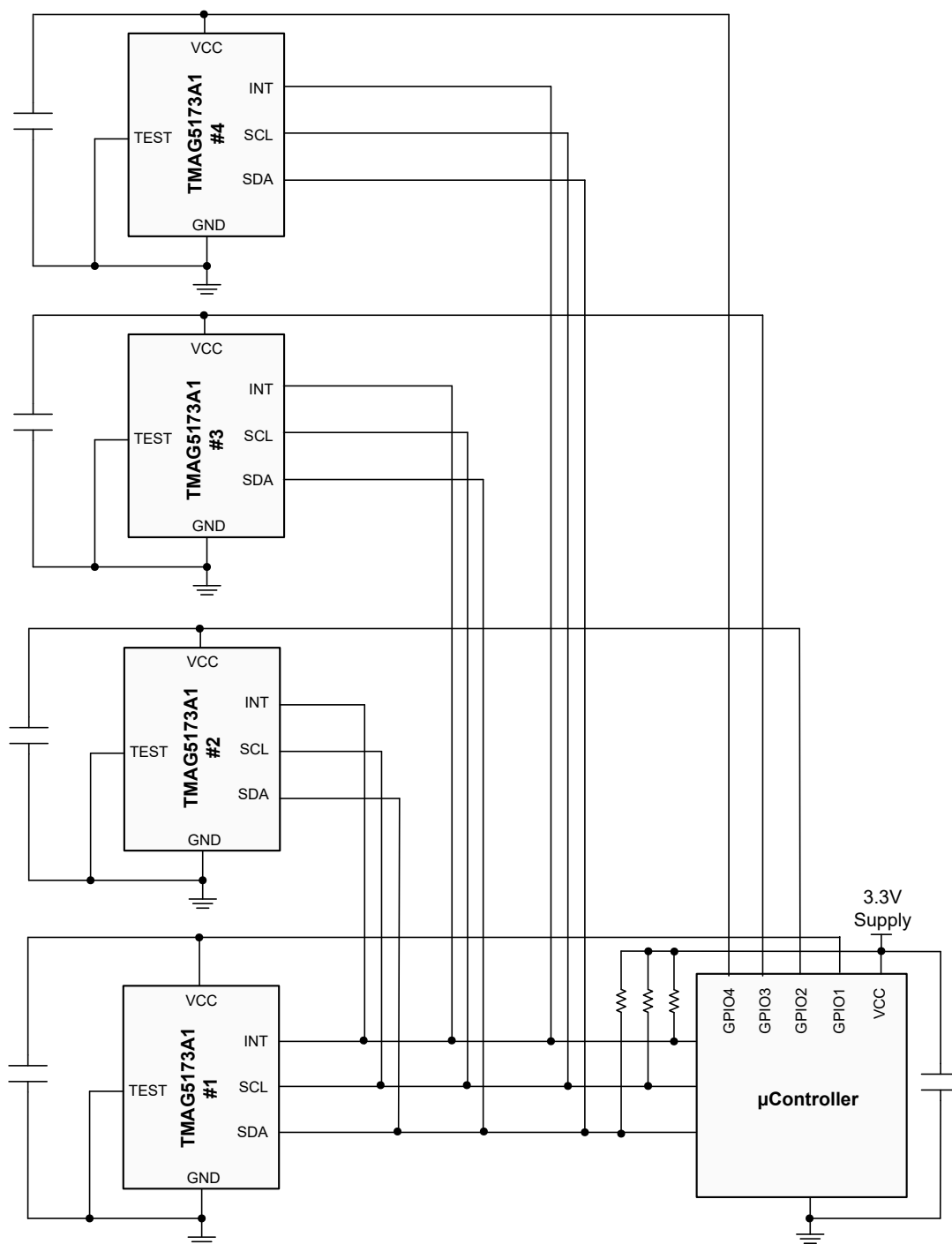
**Figure 8-10. X and Y Sensor Data for Full 360 Degree Rotation for On-Axis Measurement**



**Figure 8-11. X and Y Sensor Data for Full 360 Degree Rotation for Off-Axis Measurement**

### 8.2.2 I<sup>2</sup>C Address Expansion

The TMAG5173-Q1 is offered in four different factory-programmed I<sup>2</sup>C addresses. The device also supports additional I<sup>2</sup>C addresses through the configuration of the I2C\_ADDRESS register. There are 7 bits to select 128 different addresses. Take system limitations like bus loading, maximum clock frequency, available GPIOs from a microcontroller, and so forth, in account before selecting maximum number of sensors in a single I<sup>2</sup>C bus.



**Figure 8-12. TMAG5173-Q1 Application Diagram for I<sup>2</sup>C Address Expansion**

### 8.2.2.1 Design Requirements

Use the parameters listed in [Table 8-2](#) for this design example.

**Table 8-3. Design Parameters**

| PARAMETERS       | DESIGN TARGET |
|------------------|---------------|
| Device orderable | TMAG5173A1-Q1 |
| VCC              | 3.3 V         |

**Table 8-3. Design Parameters (continued)**

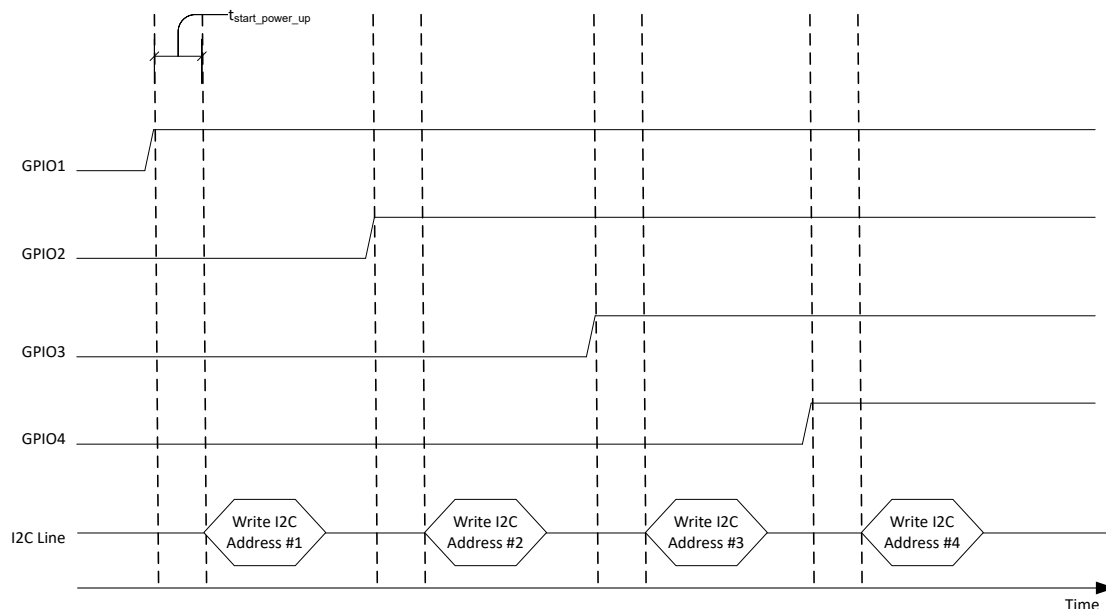
| PARAMETERS                | DESIGN TARGET                                                                           |
|---------------------------|-----------------------------------------------------------------------------------------|
| # of Devices in same bus  | 4 (same method can be used to expand the number of sensors in the I <sup>2</sup> C bus) |
| Design objective          | Optimize the # GPIO and component count                                                 |
| Current supply per sensor | 5-mA, supplied by a microcontroller GPIO                                                |

**8.2.2.2 Detailed Design Procedure**

Select GPIO with current supply capability of 5 mA. Figure 8-12 shows that the SCL, SDA lines and  $\overline{\text{INT}}$  pin can be shared. However, the function of the  $\overline{\text{INT}}$  pin must be analyzed when shared by multiple sensors. As an example, if the sensors are configured to generate interrupt through the  $\overline{\text{INT}}$  pin, the microcontroller needs to read all the sensors to determine which specific one sending the interrupt. Take the following steps sequentially to assign new I<sup>2</sup>C addresses to the four TMAG5173-Q1 shown in Figure 8-13:

- Turn on the GPIO#1 and wait until  $t_{\text{start\_power\_up}}$  time is elapsed.
- Address the device#1 with factory programmed address. Write to the I2C\_ADDRESS register to assign a new address.
- Turn on the GPIO#2 and wait until  $t_{\text{start\_power\_up}}$  time is elapsed.
- Address the device#2 with factory programmed address. Write to the I2C\_ADDRESS register to assign a new unique address.
- Turn on the GPIO#3 and wait until  $t_{\text{start\_power\_up}}$  time is elapsed.
- Address the device#3 with factory programmed address. Write to the I2C\_ADDRESS register to assign a new unique address.
- Turn on the GPIO#4 and wait until  $t_{\text{start\_power\_up}}$  time is elapsed.
- Address the device#4 with factory programmed address. Write to the I2C\_ADDRESS register to assign a new unique address.

Repeat the above steps if there is a power outage or power-up reset condition.

**Figure 8-13. Power-Up Timing and I<sup>2</sup>C Address Allocation for the Four Sensors****8.3 Best Design Practices**

The TMAG5173-Q1 updates the result registers at the end of a conversion. I<sup>2</sup>C read of the result register must be synchronized with the conversion update time to avoid reading a result data while the result register is being updated. For applications with a tight timing budget, use the  $\overline{\text{INT}}$  signal to notify the primary when a conversion is complete.

## 8.4 Power Supply Recommendations

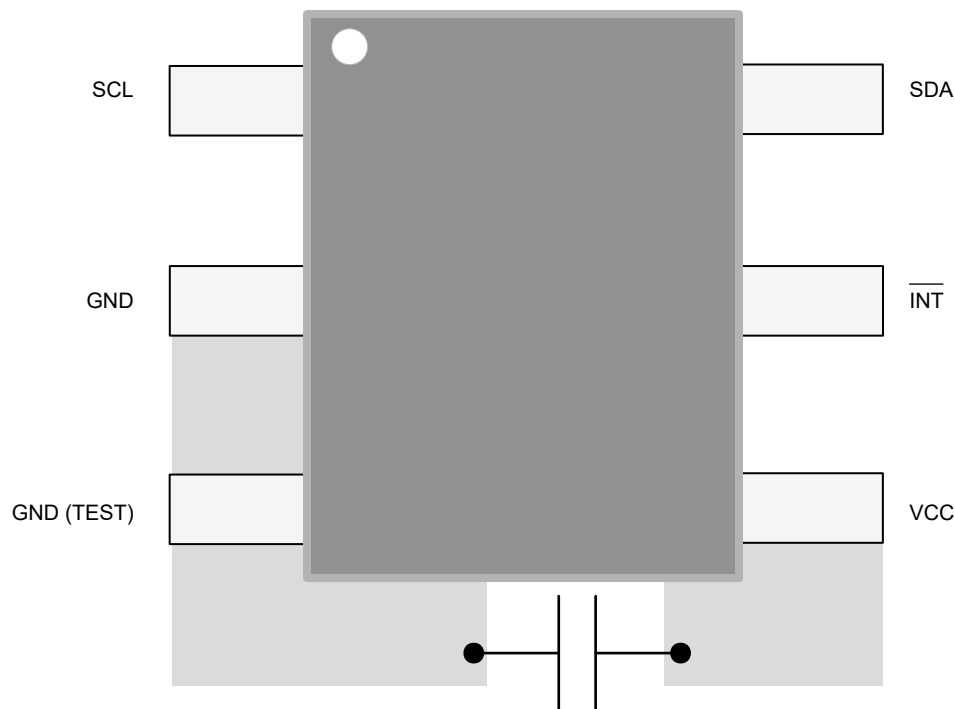
A decoupling capacitor close to the device must be used to provide local energy with minimal inductance. TI recommends using a ceramic capacitor with a value of at least 0.01  $\mu\text{F}$ . Connect the TEST pin to ground.

## 8.5 Layout

### 8.5.1 Layout Guidelines

Magnetic fields pass through most nonferromagnetic materials with no significant disturbance. Embedding Hall effect sensors within plastic or aluminum enclosures and sensing magnets on the outside is common practice. Magnetic fields also easily pass through most printed circuit boards (PCBs), which makes placing the magnet on the opposite side of the PCB possible.

### 8.5.2 Layout Example



**Figure 8-14. Layout Example With TMAG5173-Q1**

## 9 Device and Documentation Support

### 9.1 Documentation Support

#### 9.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [HALL-ADAPTER-EVM User's Guide](#) (SLYU043)
- Texas Instruments, [TMAG5173 Evaluation Manual user's guide](#) (SLYU058)
- Texas Instruments, [Angle Measurement With Multi-Axis Linear Hall-Effect Sensors](#) application note (SBAA463)
- Texas Instruments, [Absolute Angle Measurements for Rotational Motion Using Hall-Effect Sensors](#) application brief (SBAA503)
- Texas Instruments, [Limit Detection for Tamper and End-of-Travel Detection Using Hall-Effect Sensors](#) application brief (SBOA514)

#### 9.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 9.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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#### 9.4 Trademarks

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#### 9.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 9.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|-------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TMAG5173A1QDBVRQ1 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   |                         | <a href="#">Samples</a> |
| TMAG5173A2QDBVRQ1 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   |                         | <a href="#">Samples</a> |
| TMAG5173B1QDBVRQ1 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   |                         | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

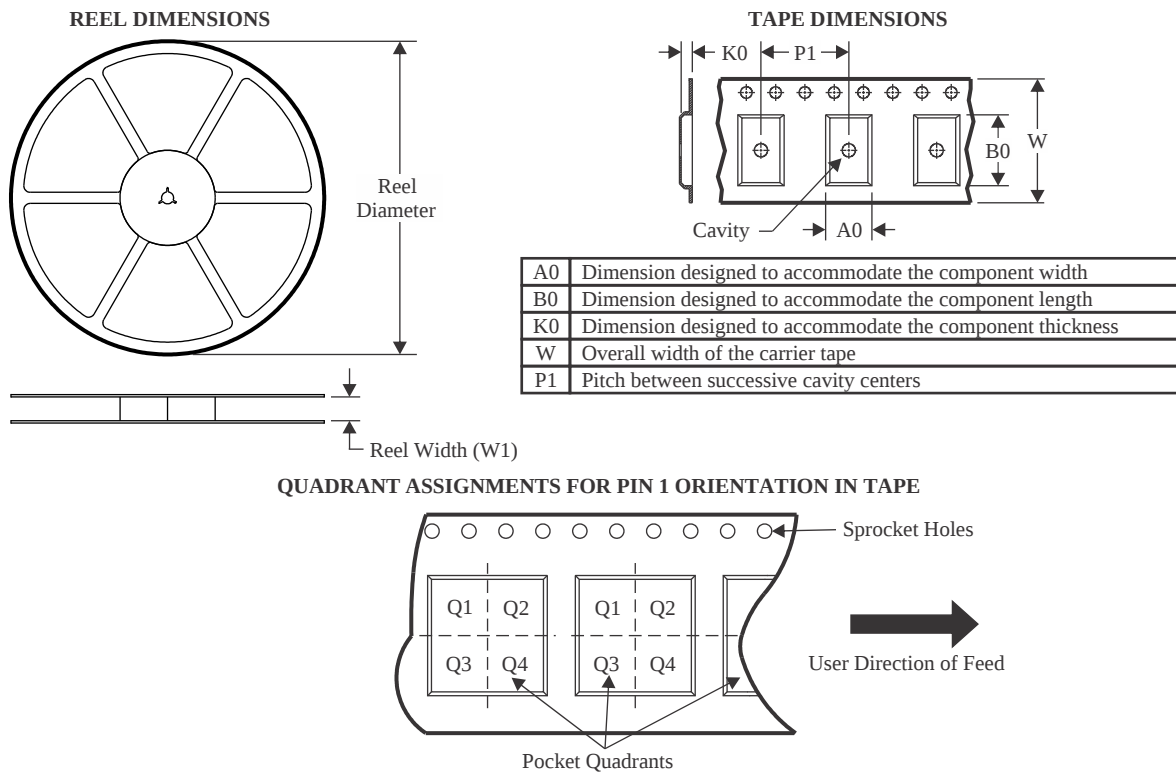
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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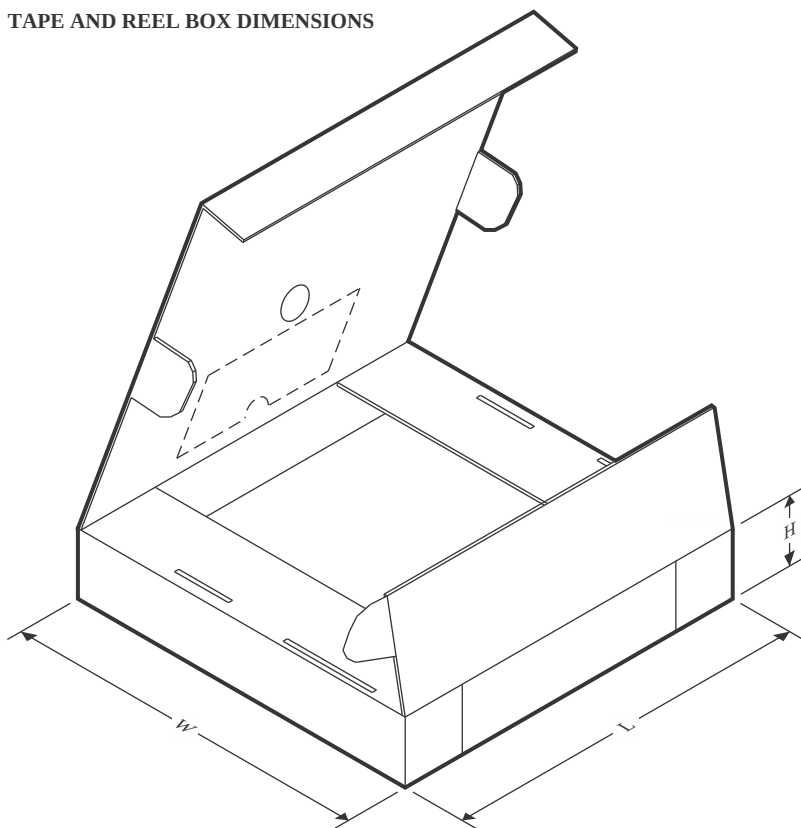
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TMAG5173A1QDBVRQ1 | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TMAG5173A2QDBVRQ1 | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TMAG5173B1QDBVRQ1 | SOT-23       | DBV             | 6    | 3000 | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TMAG5173A1QDBVRQ1 | SOT-23       | DBV             | 6    | 3000 | 190.0       | 190.0      | 30.0        |
| TMAG5173A2QDBVRQ1 | SOT-23       | DBV             | 6    | 3000 | 190.0       | 190.0      | 30.0        |
| TMAG5173B1QDBVRQ1 | SOT-23       | DBV             | 6    | 3000 | 190.0       | 190.0      | 30.0        |

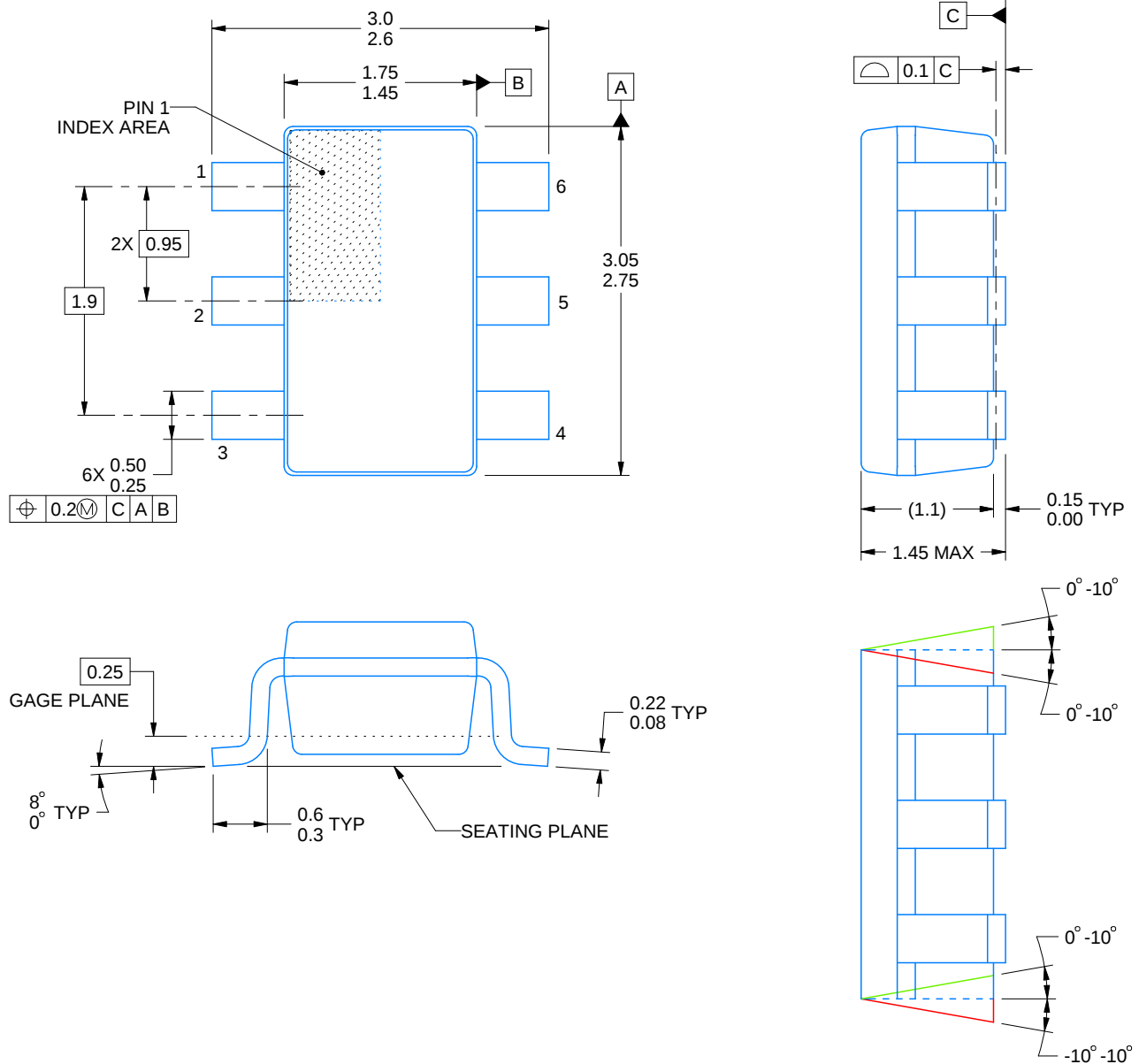
DBV0006A



## PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



ALTERNATIVE PACKAGE SINGULATION VIEW

4214840/D 09/2023

### NOTES:

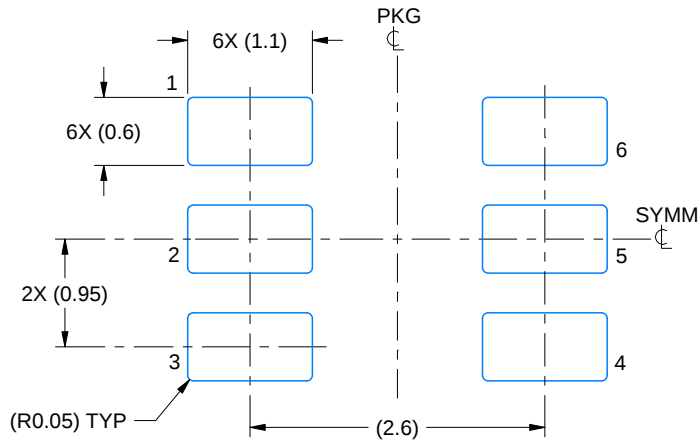
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.
4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
5. Reference JEDEC MO-178.

# EXAMPLE BOARD LAYOUT

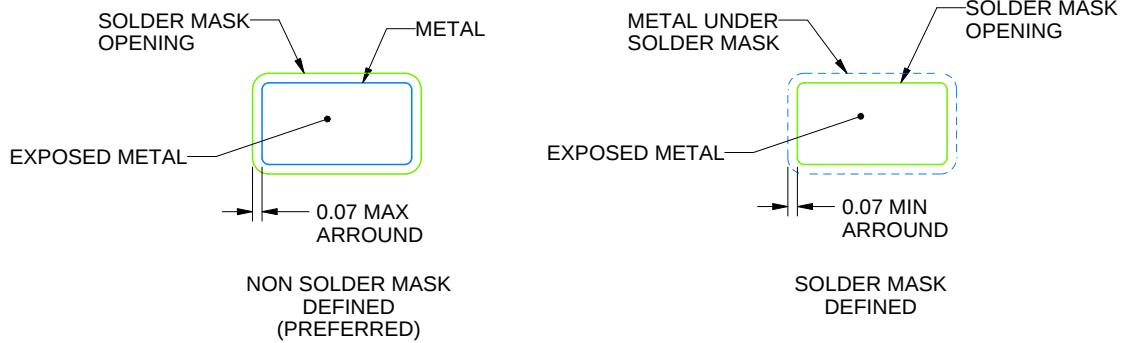
DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

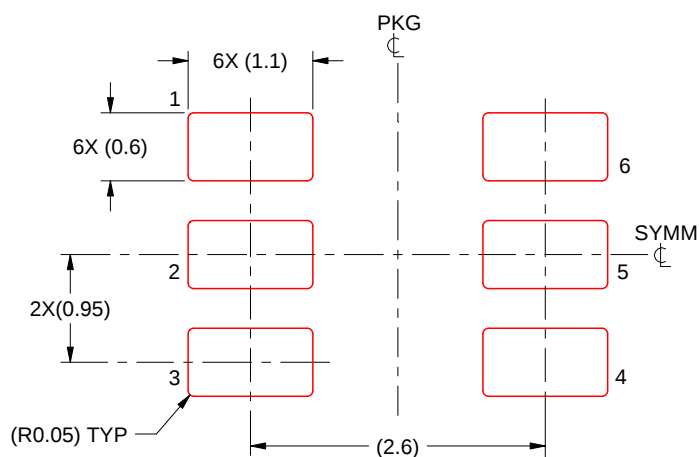
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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